### TWELVE CHANNEL E3/DS3/STS-1 LINE INTERFACE UNIT

OCTOBER 2007 REV. 1.0.3

### **GENERAL DESCRIPTION**

The XRT73R12 is a twelve channel fully integrated Line Interface Unit (LIU) featuring EXAR's R<sup>3</sup> Technology (Reconfigurable, Relayless Redundancy) for E3/DS3/STS-1 applications. The LIU incorporates 12 independent Receivers and Transmitters in a single 420 Lead TBGA package.

Each channel of the XRT73R12 can be independently configured to operate in E3 (34.368 MHz), DS3 (44.736 MHz) or STS-1 (51.84 MHz). Each transmitter can be turned off and tri-stated for redundancy support or for conserving power.

The XRT73R12's differential receiver provides high noise interference margin and is able to receive data over 1000 feet of cable or with up to 12 dB of cable attenuation.

The XRT73R12 provides a Parallel Microprocessor Interface for programming and control.

The XRT73R12 supports analog, remote and digital loop-backs. The device also has a built-in Pseudo Random Binary Sequence (PRBS) generator and detector with the ability to insert and detect single bit error for diagnostic purposes.

### **APPLICATIONS**

- E3/DS3 Access Equipment
- DSLAMs
- Digital Cross Connect Systems
- CSU/DSU Equipment
- Routers
- Fiber Optic Terminals

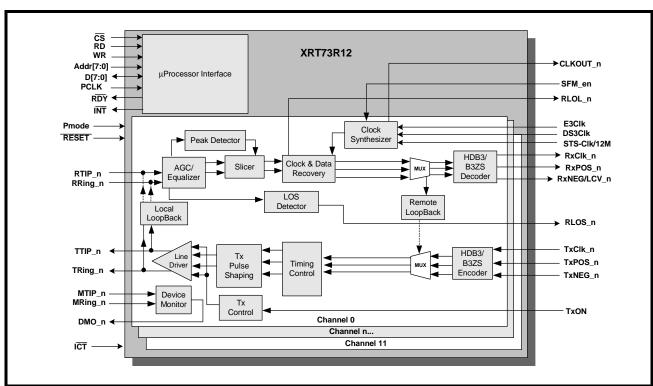


FIGURE 1. BLOCK DIAGRAM OF THE XRT 73R12

### ORDERING INFORMATION

PART NUMBER	PACKAGE	OPERATING TEMPERATURE RANGE
XRT73R12IB	420 Lead TBGA	-40°C to +85°C

### **XRT73R12**

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### **FEATURES**

### **RECEIVER**

- R<sup>3</sup> Technology (Reconfigurable, Relayless Redundancy)
- On chip Clock and Data Recovery circuit for high input jitter tolerance
- Meets E3/DS3/STS-1 Jitter Tolerance Requirement
- Detects and Clears LOS as per G.775
- Receiver Monitor mode handles up to 20 dB flat loss with 6 dB cable attenuation
- On chip B3ZS/HDB3 encoder and decoder that can be either enabled or disabled
- On-chip clock synthesizer provides the appropriate rate clock from a single 12.288 MHz Clock
- Provides low jitter output clock

### **TRANSMITTER**

- R<sup>3</sup> Technology (Reconfigurable, Relayless Redundancy)
- Compliant with Bellcore GR-499, GR-253 and ANSI T1.102 Specification for transmit pulse
- Tri-state Transmit output capability for redundancy applications
- Each Transmitter can be independently turned on or off
- Transmitters provide Voltage Output Drive

### **CONTROL AND DIAGNOSTICS**

- Parallel Microprocessor Interface for control and configuration
- Supports optional internal Transmit driver monitoring
- Each channel supports Analog, Remote and Digital Loop-backs
- Single 3.3 V ± 5% power supply
- 5 V Tolerant digital inputs
- Available in 420 pin TBGA Thermally enhanced Package

• - 40℃ to 85℃ Industrial Temperature Range

### TRANSMIT INTERFACE CHARACTERISTICS

- Accepts either Single-Rail or Dual-Rail data from Terminal Equipment and generates a bipolar signal to the line
- Integrated Pulse Shaping Circuit
- Built-in B3ZS/HDB3 Encoder (which can be disabled)
- Accepts Transmit Clock with duty cycle of 30%-70%
- Generates pulses that comply with the ITU-T G.703 pulse template for E3 applications
- Generates pulses that comply with the DSX-3 pulse template, as specified in Bellcore GR-499-CORE and ANSI T1.102 1993
- Generates pulses that comply with the STSX-1 pulse template, as specified in Bellcore GR-253-CORE
- Transmitter can be turned off in order to support redundancy designs

### RECEIVE INTERFACE CHARACTERISTICS

- Integrated Adaptive Receive Equalization (optional) for optimal Clock and Data Recovery
- Declares and Clears the LOS defect per ITU-T G.775 requirements for E3 and DS3 applications
- Meets Jitter Tolerance Requirements, as specified in ITU-T G.823\_1993 for E3 Applications
- Meets Jitter Tolerance Requirements, as specified in Bellcore GR-499-CORE for DS3 Applications
- Declares Loss of Lock (LOL) Alarm
- Built-in B3ZS/HDB3 Decoder (which can be disabled)
- Recovered Data can be muted while the LOS Condition is declared
- Outputs either Single-Rail or Dual-Rail data to the Terminal Equipment

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# PIN DESCRIPTIONS (BY FUNCTION)

### SYSTEM-SIDE TRANSMIT INPUT AND TRANSMIT CONTROL PINS

Pin#	SIGNAL NAME	Түре	DESCRIPTION
P4	TxON	I	Transmit On/Off Input
			Upon power up, the transmitters are powered on. Turning the transmitters On or Off is selected through the microprocessor interface by programming the appropriate channel register if this pin is pulled "High". If the TxON pin is pulled "Low", all 12 transmitters are powered off.
			<b>NOTE:</b> TxON is ideal for redundancy applications. See the R <sup>3</sup> Technology section of this datasheet for more details. Internally pulled "High".
F22	TxCLK0	I	Transmit Clock Input
AA22	TxCLK1		These input pins have three functions:
H22	TxCLK2		They function as the timing source for the Transmit Section of the
Y23	TxCLK3		corresponding channel within the XRT73R12.
G26	TxCLK4		They are used by the Transmit Section of the LIU IC to sample the
AA25	TxCLK5		corresponding TxPOS_n and TxNEG_n input pins.
G1	TxCLK6		They are used to clock the PRBS generator
AA2	TxCLK7		NOTE: The user is expected to supply a 44.736MHz ± 20ppm clock signal
H5	TxCLK8		(for DS3 applications), 34.368MHz ± 20 ppm clock signal (for E3
Y4	TxCLK9		applications) or a 51.84MHz ± 4.6ppm clock signal (for STS-1,
F5	TxCLK10		Stratum 3E or better applications).
AA5	TxCLK11		
E23	TxPOS0	I	Transmit Positive Data Input
AB24	TxPOS1		The function of these digitial input pins depends upon whether the corre-
J22	TxPOS2		sponding channel has been configured to operate in the Single-Rail or
AA23	TxPOS3		Dual-Rail Mode.
G25	TxPOS4		Single Rail Mode - Transmit Data Input
AA26	TxPOS5		Operating in the Single-Rail Mode; all transmit input data will be serially
G2	TxPOS6		applied to this input pin. This signal will be latched into the Transmit Section circuitry on the active edge of the TxCLK_n signal.
AA1	TxPOS7		The Transmit Section of the LIU IC will then encode this data into either the
J5	TxPOS8		B3ZS line code (for DS3 and STS-1 applications) or the HDB3 line code
AA4	TxPOS9		(for E3 applications).
E4	TxPOS10		Dual Rail Mode - Transmit Positive Data Input
AB3	TxPOS11		In the Dual-Rail Mode, the user should apply a pulse to this input pin when a positive-polarity pulse is to be transmitted onto the line. This signal will be latched into the Transmit Section circuitry upon the active edge of the TxCLK_n signal,.  The Transmit Section of the LIU IC will NOT encode this data into either the B3ZS or HDB3 line codes. If the user configures the LIU IC to operate in the Dual-Rail Mode, B3ZS/HDB3 encoding must have already been done
			prior to this input.

### SYSTEM-SIDE TRANSMIT INPUT AND TRANSMIT CONTROL PINS

Pin#	SIGNAL NAME	Түре	DESCRIPTION
C25	TxNEG0	I	Transmit Negative Data Input
AB25	TxNEG1		When a Channel has been configured to operate in the Dual-Rail Mode,
H23	TxNEG2		the user should apply a pulse to this input pin anytime the Transmit Section
W23	TxNEG3		of the LIU IC to generate a negative-polarity pulse onto the line. This signal
H24	TxNEG4		will be latched into the Transmit Section circuitry upon the active edge of the TxCLK_n signal.
Y26	TxNEG5		NOTE: In the Single-Rail Mode, this input pin has no function, and should
H3	TxNEG6		be tied to GND.
Y1	TxNEG7		30 100 10 0.12.
H4	TxNEG8		
W4	TxNEG9		
C2	TxNEG10		
AB2	TxNEG11		
B24	TTip0	0	Transmit TTIP Output - Positive Polarity Signal
AE24	TTip1		These output pins along with the corresponding TRING_n output pins,
C20	TTip2		function as the Transmit DS3/E3/STS-1 Line output signal drivers for a
AD20	TTip3		given channel of the XRT73R12.
C16	TTip4		Connect this signal and the corresponding TRING_n output signal to a 1:1 transformer.
AD16	TTip5		Whenever the Transmit Section of the Channel generates and transmits a
C11	TTip6		positive-polarity pulse onto the line, this output pin will be pulsed to a high
AD11	TTip7		ervoltage than its corresponding TRING_n output pins.
C7	TTip8		Conversely, whenever the Transmit Section of the Channel generates and
AD7	TTip9		transmit a negative-polarity pulse onto the line, this output pin will be
C3	TTip10		pulsed to a lower voltage than its corresponding TRING_n output pin.
AD3	TTip11		<b>NOTE:</b> This output pin will be tri-stated whenever the TxON input pin or bit-field is set to "0".
C24	TRing0	0	Transmit Ring Output - Negative Polarity Signal
AD24	TRing1		These output pins along with the corresponding TTIP_n output pins, func-
B20	TRing2		tion as the Transmit DS3/E3/STS-1 Line output signal drivers for a given
AE20	TRing3		channel, within the XRT73R12.
B16	TRing4		Connect this signal and the corresponding TTIP_n output signal to a 1:1 transformer.
AE16	TRing5		Whenever the Transmit Section of the Channel generates and transmits a
B11	TRing6		positive-polarity pulse onto the line, this output pin will be pulsed to a lower
AE11	TRing7		voltage than its corresponding TTIP_n output pin.
B7	TRing8		Conversely, whenever the Transmit Section of the Channel generates and
AE7	TRing9		transmit a negative-polarity pulse onto the line, this output pin will be
B3	TRing10		pulsed to a higher voltage than its corresponding TTIP_n output pin.
AE3	TRing11		<b>NOTE:</b> This output pin will be tri-stated whenever the TxON input pin or bit-field is set to "0".

# SYSTEM-SIDE TRANSMIT INPUT AND TRANSMIT CONTROL PINS

Pin#	SIGNAL NAME	Түре	DESCRIPTION
C23	MTip0	I	Monitor Tip Input - Positive Polarity Signal
AD23	MTip1		These input pins along with MRing_n function as the Transmit Drive Moni-
D19	MTip2		tor Output (DMO) input monitoring pins. (1) To monitor the Transmit Out-
AC19	MTip3		put line signal and (2) to perform this monitoring externally, then this pin
D15	MTip4		MUST be connected to the corresponding TTIP_n output pin via a 270Ω series resistor. Similarly, the MRING_n input pin MUST also be connected
AC15	MTip5		to its corresponding TRING_n output pin via a 270Ω series resistor.
E11	MTip6		The MTIP_n and MRING_n input pins will continuously monitor the Trans-
AB11	MTip7		mit Output line signal via the TTIP_n and TRING_n output pins for bipolar
E8	MTip8		activity. If these pins do not detect any bipolar activity for 128 bit periods,
AB8	MTip9		then the Transmit Drive Monitor circuit will drive the corresponding DMO_n
C4	MTip10		output pin "High" in order to denote a possible fault condition in the Transmit Output Line signal path.
AD4	MTip11		
			<b>NOTE:</b> These input pins are inactive if the user chooses to internally monitor the Transmit Output line signal.
D23	MRing0	I	Monitor Ring Input
AC23	MRing1		These input pins along with MTIP_n function as the Transmit Drive Monitor
E19	MRing2		Output (DMO) input monitoring pins. (1) To monitor the Transmit Output
AB19	MRing3		line signal and (2) to perform this monitoring externally, then this input pin
E16	MRing4		MUST be connected to the corresponding TRING_n output pin via a 270Ω series resistor. Similarly, the MTIP_n input pin MUST be connected to its
AB16	MRing5		corresponding TTIP_n output pin via a $270\Omega$ series resistor.
D10	MRing6		The MTIP_n and MRING_n input pins will continuously monitor the Trans-
AC10	MRing7		mit Output line signal via the TTIP_n and TRING_n output pins for bipolar
D8	MRing8		activity. If these pins do not detect any bipolar activity for 128 bit periods,
AC8	MRing9		then the Transmit Drive Monitor circuit will drive the corresponding DMO_n
D4	MRing10		output pin "High" to indicate a possible fault condition in the Transmit Output Line signal path.
AC4	MRing11		<b>Note:</b> These input pins are inactive if the user chooses to internally
			monitor the Transmit Output line signal.
N3	DMO0	0	Drive Monitor Output
N4	DMO1		These output signals are used to indicate a fault condition within the Trans-
N5	DMO2		mit Output signal path.
N1	DMO3		This output pin will toggle "High" anytime the Transmit Drive Monitor cir-
M1	DMO4		cuitry either, via the corresponding MTIP and MRING input pins or internally, detects no bipolar pulses via the Transmit Output line signal (e.g., via
L2	DMO5		the TTIP_m and TRING_m output pins) for 128 bit-periods.
M2	DMO6		This output pin will be driven "Low" anytime the Transmit Drive Monitor cir-
M3	DMO7		cuitry has detected at least one bipolar pulse via the Transmit Output line
M4	DMO8		signal within the last 128 bit periods.
M5	DMO9		
K2	DMO10		
J1	DMO11		

### SYSTEM-SIDE RECEIVE OUTPUT AND RECEIVE CONTROL PINS

Pin#	SIGNAL NAME	Түре	DESCRIPTION
D25	RLOS0	0	Receive Loss of Signal Output Indicator
AD25	RLOS1		This output pin indicates Loss of Signal (LOS) Defect condition for the corre-
G23	RLOS2		sponding channel.
AA24	RLOS3		"Low" - Indicates that the corresponding Channel is NOT currently declaring the
J24	RLOS4		LOS defect condition.
U24	RLOS5		"High" - Indicates that the corresponding Channel is currently declaring the LOS defect condition.
J3	RLOS6		defect condition.
U3	RLOS7		
G4	RLOS8		
AA3	RLOS9		
D2	RLOS10		
AD2	RLOS11		
G22	RLOL0	0	Receive Loss of Lock Output Indicator
AB26	RLOL1		This output pin indicates Loss of Lock (LOL) condition for the corresponding
K22	RLOL2		channel.
U22	RLOL3		"Low" - Indicates that the corresponding Channel is NOT declaring the LOL
L24	RLOL4		condition.
W25	RLOL5		"High" - Indicates that the corresponding Channel is currently declaring the LOL condition.
L3	RLOL6		Note: The Receive Section of a given channel will declare the LOL condition
W2	RLOL7		anytime the frequency of the Recovered Clock (RCLK) signal differs
K5	RLOL8		from that of the reference clock programmed for that channel by 0.5%
U5	RLOL9		or more.
G5	RLOL10		
AB1	RLOL11		
E25	RxPOS0	0	Receive Positive Data Output
AD26	RxPOS1		The function of these output pins depends upon whether the channel has been
G24	RxPOS2		configured to operate in the Single-Rail or Dual-Rail Mode.
Y24	RxPOS3		Dual-Rail Mode - Receive Positive Polarity Data Output
L22	RxPOS4		If the channel has been configured to operate in the Dual-Rail Mode, then all positive-polarity data will be output via this pin. The negative-polarity data will
T22	RxPOS5		be output via the corresponding RxNEG_n pin. In other words, the Receive
L5	RxPOS6		Section of the corresponding Channel will pulse this output pin "High" for one
T5	RxPOS7		period of RCLK_n anytime it receives a positive-polarity pulse via the RTIP/
G3	RxPOS8		RRING input pins.
Y3	RxPOS9		The data output via this pin is updated upon the active edge of RxCLK_n output
E2	RxPOS10		clock signal.
AD1	RxPOS11		Single-Rail Mode - Receive Data Output
			In the Single-Rail Mode, all Receive (or Recovered) data will be output via this pin.
			The data output via this pin is updated upon the active edge of the RCLK_n output clock signal.

# SYSTEM-SIDE RECEIVE OUTPUT AND RECEIVE CONTROL PINS

Pin#	SIGNAL NAME	Түре	DESCRIPTION
F23	RxNEG/LCV0	0	Receive Negative Data Output/Line Code Violation
AC26	RxNEG/LCV1		The function of these pins depends on whether the XRT73R12 is configured in
F24	RxNEG/LCV2		Single Rail or Dual Rail mode.
U23	RxNEG/LCV3		Dual-Rail Mode - Receive Negative Polarity Data Output
L23	RxNEG/LCV4		In the Dual-Rail Mode, all negative-polarity data will be output via this pin. The
T24	RxNEG/LCV5		positive-polarity data will be output via the corresponding RxPOS_n output pin. In other words, the Receive Section of the corresponding Channel will pulse this
L4	RxNEG/LCV6		output pin "High" for one period of RxCLK_n anytime it receives a negative-
T3	RxNEG/LCV7		polarity pulse via the RTIP/RRING input pins.
F3	RxNEG/LCV8		The data output via this pin is updated upon the active edge of the RCLK_n
U4	RxNEG/LCV9		output clock signal.
F4	RxNEG/LCV10		Single-Rail Mode - Line Code Violation Indicator Output
AC1	RxNEG/LCV11		In the Single-Rail Mode, this output pin will function as the Line Code Violation indicator output.
			In this configuration, the Receive Section of the Channel will pulse this output pin "High" for at least one RCLK period whenever it detects either an LCV (Line Code Violation) or an EXZ (Excessive Zero Event).
			The data that is output via this pin is updated upon the active edge of the
			RCLK_n output clock signal.
E24	RxCLK0	0	Receive Clock Output
AC25	RxCLK1		This output pin functions as the Receive or recovered clock signal. All Receive
J23	RxCLK2		(or recovered) data will output via the RxPOS_n and RxNEG_n outputs upon
V23	RxCLK3		the active edge of this clock signal.
K24	RxCLK4		Additionally, if the device/channel has been configured to operate in the Single-Rail Mode, then the RNEG_n/LCV_n output pins will also be updated upon the
T23	RxCLK5		active edge of this clock signal.
K3	RxCLK6		300.10 04.50 0. 1.1.0 0.00 0.00 0.00 0.00 0.00 0.
T4	RxCLK7		
J4	RxCLK8		
V4	RxCLK9		
E3	RxCLK10		
AC2	RxCLK11		

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## **RECEIVE LINE SIDE PINS**

Pin#	SIGNAL NAME	TYPE	DESCRIPTION
B22	RTip0	I	Receive TIP Input
AE22	RTip1		These input pins along with the corresponding RRing_n input pin function as the
B18	RTip2		Receive DS3/E3/STS-1 Line input signal for a given channel of the XRT73R12.
AE18	RTip3		Cconnect this signal and the corresponding RRING_n input signal to a 1:1
A14	RTip4		transformer.
AF14	RTip5		Whenever the RTIP/RRING input pins are receiving a positive-polarity pulse
D13	RTip6		within the incoming DS3, E3 or STS-1 line signal, this input pin will be pulsed to a higher voltage than its corresponding RRING_n input pin.
AC13	RTip7		Conversely, whenever the RTIP/RRING input pins are receiving a negative-
B9	RTip8		polarity pulse within the incoming DS3, E3 or STS-1 line signal, this input pin
AE9	RTip9		will be pulsed to a lower voltage than its corresponding RRING_n input pin.
B5	RTip10		
AE5	RTip11		
C22	RRing0	I	Receive Ring Input
AD22	RRing1		These input pins along with the corresponding RTIP_n input pin function as the
C18	RRing2		Receive DS3/E3/STS-1 Line input signal for a given channel of the XRT73R12.
AD18	RRing3		Connect this signal and the corresponding RTIP_n input signal to a 1:1 trans-
B14	RRing4		former. (See Figure 6)
AE14	RRing5		Whenever the RTIP/RRING input pins are receiving a positive-polarity pulse
C13	RRing6		within the incoming DS3, E3 or STS-1 line signal, then this input pin will be pulsed to a lower voltage than its corresponding RTIP_n input pin.
AD13	RRing7		Conversely, whenever the RTIP/RRING input pins are receiving a negative-
C9	RRing8		polarity pulse within the incoming DS3, E3 or STS-1 line signal, then this input
AD9	RRing9		pin will be pulsed to a higher voltage than its corresponding RTIP_n input pin.
C5	RRing10		
AD5	RRing11		

### **CLOCK INTERFACE**

Pin#	SIGNAL NAME	Түре	DESCRIPTION
R5	SFM_EN	I	Single Frequency Mode Enable This input pin is used to configure the XRT73R12 to operate in the SFM (Single Frequency Mode). When this feature is invoked, the SFM Synthesizer will become active. By applying a 12.288MHz clock signal to the STS-1Clk/12M pin, the XRT73R12 will generate all of the appropriate clock signals (e.g., 34.368MHz, 44.736MHz or 51.84). The XRT73R12 internal circuitry will route each of these synthesized clock signals to the appropriate nodes of the corresponding channels in the XRT73R12.  "Low" - Disables the Single Frequency Mode. In this setting, the user is required to supply to the E3CLK, DS3CLK or STS-1CLK input pins all of the relevant clock signals that are to be used within the chip.  "High" - Enables the Single-Frequency Mode.  Note: This input pin is internally pulled low.
R1	E3Clk	I	E3 Clock Input (34.368 MHz ± 20 ppm)  If any one of the channels is configured in E3 mode, a reference clock of 34.368 MHz ± 20 ppm is applied to this input pin. If the LIU is used in E3 mode only, this pin must be connected to the DS3Clk input pin to have access to the internal microprocessor.  Note: SFM mode negates the need for this clock
T1	DS3Clk	I	DS3 Clock Input (44.736 MHz ± 20 ppm)  If any one of the channels is configured in DS3 mode, a reference clock of 44.736 MHz ± 20 ppm is applied to this input pin.  Note: SFM mode negates the need for this clock
U1	STS-1Clk/12M	I	STS-1 Clock Input (51.84 MHz ± 20 ppm)  If any one of the channels is configured in STS-1 mode, a reference clock of 51.84MHz ± 20 ppm is applied to this input pin. If the LIU is used in STS-1 mode only, this pin must be connected to the DS3Clk input pin to have access to the internal microprocessor.  Single Frequency Mode Clock Input (12.288MHz ± 20 ppm)  In Single Frequency Mode, a reference clock of 12.288 MHz ± 20 ppm is connected to this pin and the internal clock synthesizer generates the appropriate clock frequencies based on the configuration of the rates (E3, DS3 or STS-1).
C26 W22 K23 W24 J25 V25 J2 V2 K4 W3 C1 W5	CLKOUT0 CLKOUT1 CLKOUT2 CLKOUT3 CLKOUT4 CLKOUT5 CLKOUT6 CLKOUT7 CLKOUT8 CLKOUT9 CLKOUT10 CLKOUT11	O	Reference Clock Out A reference clock pin is provided for each channel that will supply a precise data rate frequency derived from either the Clock input pin (E3Clk, DS3Clk, or STS-1Clk) or the 12.288MHz input in SFM mode. This frequency will be as stable as the original source. It is designed to provide the attached framer with its appropriate reference clock.

### REV. 1.0.3

### **GENERAL CONTROL PINS**

Pin#	SIGNAL NAME	Түре	DESCRIPTION
P3	TEST	***	Factory Test Mode Input Pin This pin must be connected to GND for normal operation.  Note: This input pin is internally pulled "Low".
AE25	TRST	I	Test Reset Test Boundary Scan
AB23	TMS	I	Test Mode Select Test Boundary Scan
AB5	TCK	I	Test Clock Test Boundary Scan
AB4	TDI	I	Test Data Input Test Boundary Scan
AE2	TDO	0	Test Data Output Test Boundary Scan

### MICROPROCESSOR PARALLEL INTERFACE -

Pin#	SIGNAL NAME	Түре	DESCRIPTION
J26	Pmode	I	This pin controls the Microprocessor Parallel Interface mode.  "High" sets a Synchronous clocked interface mode with a clock from the Host.  "Low" sets an Asynchronous mode where a clock internal to the XRT73R12 will time the operations.
P24	PCLK	1	High speed clock supplied by the Host to provide timing in the Synchronous Interface mode. This signal must be a square-wave.
N24	CS	I	Chip Select Input (active low) Initiates a read or write operation. When "High", no parallel communication is active between the LIU and the Host.
N22	WR	I	Write Input (active low) Enables the Host to write data D[7:0] into the LIU register space at address Addr[7:0].
N23	RD	I	Read Input (active low)  Commands the LIU to transfer the contents of a register specified by Addr[7:0] to the Host.
N25	RDY	0	Ready Line Output (active low) Provides a handshake between the LIU and the Host that communicates when an operation has been completed.  Note: This pin must be pulled "High" with a $3k\Omega \pm 1\%$ resistor.

# MICROPROCESSOR PARALLEL INTERFACE -

Pin#	SIGNAL NAME	Түре	DESCRIPTION
K25	Addr0	I	An eight bit direct address bus that specifies the source/destination register for
M22	Addr1		a Read or Write operation.
M23	Addr2		
M24	Addr3		
K26	Addr4		
L26	Addr5		
M26	Addr6		
N26	Addr7		
P22	D0	I/O	An eight bit bi-directional data bus that provides the data into the LIU for a Write
R26	D1		operation or the data out to the Host for a Read operation.
T26	D2		
U26	D3		
R25	D4		
R24	D5		
R23	D6		
R22	D7		
P26	ĪNT	0	Interrupt Active Output (active low)
			Normally, this output pin will be pulled "High". However, if the user enables interrupts within the LIU, and if those conditions occur, the XRT73R12 will signal an interrupt from the Microprocessor by pulling this output pin "Low". The Host Microprocessor must ascertain the source of the interrupt and service it. Reading the source of the interrupt will clear the flag and the INT pin will go back high unless another interrupt has gone active.
			This pin will remain "Low" until the Interrupt has been serviced.
			2. This pin must be pulled "High" with a $3k\Omega \pm 1\%$ resistor
N2	RESET	I	RESET Input  Pulsing this input "Low" causes the XRT73R12 to reset the contents of the onchip Command Registers to their default values. As a consequence, the XRT73R12 will then also be operating in its default condition.  For normal operation this input pin should be at a logic "High".
			Note: This input pin is internally pulled high.

### **POWER SUPPLY PINS**

PIN NAME	PIN NUMBERS	DESCRIPTION
RVDD0 RVDD1 RVDD2 RVDD3 RVDD4 RVDD5 RVDD6 RVDD7 RVDD8 RVDD9 RVDD10 RVDD11	D22 AC22 D18 AC18 E15 AB15 E12 AB12 A9 AF9 D5 AC5	Receive Analog Power Supply (3.3V ±5%) RVDD should not be shared with other power supplies. It is recommended that RVDD be isolated from the digital power supply DVDD and the analog power supply TVDD. For best results, use an internal power plane for isolation. If an internal power plane is not available, a ferrite bead can be used. Each power supply pin should be bypassed to ground through an external 0.1μF capacitor.
TVDD0 TVDD1 TVDD2 TVDD3 TVDD4 TVDD5 TVDD6 TVDD7 TVDD8 TVDD9 TVDD10 TVDD11	B23 AE23 B19 AE19 B15 AE15 B10 AE10 A6 AF6 B4 AE4	Transmit Analog Power Supply (3.3V ±5%) TVDD can be shared with DVDD. However, it is recommended that TVDD be isolated from the analog power supply RVDD. For best results, use an internal power plane for isolation. If an internal power plane is not available, a ferrite bead can be used. Each power supply pin should be bypassed to ground through an external 0.1μF capacitor.
AVDD		Analog Power Supply (3.3V ±5%)  AVDD should be isolated from the digital power supplies. For best results, use an internal power plane for isolation. If an internal power plane is not available, a ferrite bead can be used. Each power supply pin should be bypassed to ground through at least one 0.1µF capacitor.
DVDD	V24, Y22, AF21, AF20, AF17, AF16, AD14, AD12,	available, a ferrite bead can be used. Every two DVDD power supply pins should be bypassed to ground through at least one $0.1\mu F$ capacitor.



### **GROUND PINS**

PIN NAME	PIN NUMBERS	DESCRIPTION
RGND0	A22	Receive Analog Ground
RGND1	AF22	It's recommended that all ground pins of this device be tied together.
RGND2	A18	
RGND3	AF18	
RGND4	E14	
RGND5	AB14	
RGND6	E13	
RGND7	AB13	
RGND8	D9	
RGND9	AC9	
RGND10 RGND11	A5	
KGNDTI	AF5	
TGND0	A23	Transmit Analog Ground
TGND1	AF23	It's recommended that all ground pins of this device be tied together.
TGND2	A19	
TGND3	AF19	
TGND4	A15	
TGND5 TGND6	AF15	
TGND0	A10	
TGND8	AF10	
TGND9	B6	
TGND10	AE6	
TGND11	A4	
	AF4	
AGND	A1, A2, A25, A26, B1, B2, B25, B26, C8, C10, C17, C19, C21, D17, D21, E5, E22, L25, U25, AB22, AB20, AB17, AB10, AB7, R3, L1, E7, E10, B12, B13, E17, E20, T2, U2, AC17, AC21, AD8, AD10, AD15, AD17, AD19, AD21, AE1, AE12, AE13, AE26, AF1, AF2, AF25, AF26, C15	It's recommended that all ground pins of this device be tied together.
DGND	E26, F26, H26, P23, , V26, Y25, V22, AC24, AC20, AC16, AC14, AC12, AC11, AE8, AE17, AE21, AC7, AC6, AC3, V5, Y2, V1, R2, P1, H1, F1, E1, D3, D7, B8, D6, D11, D12, D14, D16, B17, D20, B21, D24	It's recommended that all ground pins of this device be tied together.



### TWELVE CHANNEL E3/DS3/STS-1 LINE INTERFACE UNIT

TABLE 1: LIST BY PIN NUMBER

PIN PIN NAME AGND Α1 A2 **AGND** DVDD А3 A4 TGND10 Α5 RGND10 A6 TVDD8 Α7 DVDD DVDD Α8 A9 RVDD8 A10 TGND6 A11 DVDD A12 **AVDD** A13 **AVDD** A14 RTip4 A15 TGND4 A16 DVDD A17 DVDD A18 RGND2 A19 TGND2 A20 DVDD A21 DVDD A22 RGND0 A23 TGND0 DVDD A24 A25 **AGND** A26 **AGND** В1 **AGND** B2 **AGND** В3 TRing10 B4 TVDD10 B5 RTip10

TABLE 1: LIST BY PIN NUMBER

Pin	PIN NAME
В6	TGND8
В7	TRing8
В8	DGND
В9	RTip8
B10	TVDD6
B11	TRing6
B12	AGND
B13	AGND
B14	RRing4
B15	TVDD4
B16	TRing4
B17	DGND
B18	RTip2
B19	TVDD2
B20	TRing2
B21	DGND
B22	RTip0
B23	TVDD0
B24	TTip0
B25	AGND
B26	AGND
C1	CLKOUT10
C2	TxNEG10
C3	TTip10
C4	MTip10
C5	RRing10
C6	DVDD
C7	TTip8
C8	AGND
C9	RRing8
C10	AGND
C11	TTip6

TABLE 1: LIST BY PIN

NUMBER				
PIN PIN NAME				
C12	DVDD			
C13	RRing6			
C14	DVDD			
C15	AGND			
C16	TTip4			
C17	AGND			
C18	RRing2			
C19	AGND			
C20	TTip2			
C21	AGND			
C22	RRing0			
C23	MTip0			
C24	TRing0			
C25	TxNEG0			
C26	CLKOUT0			
D1	DVDD			
D2	RLOS10			
D3	DGND			
D4	MRing10			
D5	RVDD10			
D6	DGND			
D7	DGND			
D8	MRing8			
D9	RGND8			
D10	MRing6			
D11	DGND			
D12	DGND			
D13	RTip6			
D14	DGND			
D15	MTip4			
D16	DGND			
D17	AGND			

TABLE 1: LIST BY PIN

PIN         PIN NAME           D18         RVDD2           D19         MTip2	
D19 MTip2	
D20 DGND	
D21 AGND	
D22 RVDD0	
D23 MRing0	
D24 DGND	
D25 RLOS0	
D26 DVDD	
E1 DGND	
E2 RxPOS10	)
E3 RxCLK10	)
E4 TxPOS10	)
E5 AGND	
E6 AVDD	
E7 AGND	
E8 MTip8	
E9 AVDD	
E10 AGND	
E11 MTip6	
E12 RVDD6	
E13 RGND6	
E14 RGND4	
E15 RVDD4	
E16 MRing4	
E17 AGND	
E18 AVDD	
E19 MRing2	
E20 AGND	
E21 AVDD	
E22 AGND	
E23 TxPOS0	





Table 1: List by Pin Number		Таві	LE 1: LIST BY PIN NUMBER	TABLI	TABLE 1: LIST BY PIN NUMBER		TABLE 1: LIST BY PIN NUMBER	
PIN	PIN NAME	PIN	PIN NAME	PIN	PIN NAME	Pin	PIN NAME	
E24	RxCLK0	H26	DGND	M2	DMO6	R4	AVDD	
E25	RxPOS0	J1	DMO11	М3	DMO7	R5	SFM_EN	
E26	DGND	J2	CLKOUT6	M4	DMO8	R22	D7	
F1	DGND	J3	RLOS6	M5	DMO9	R23	D6	
F2	DVDD	J4	RxCLK8	M22	Addr1	R24	D5	
F3	RxNEG/LCV8	J5	TxPOS8	M23	Addr2	R25	D4	
F4	RxNEG/LCV10	J22	TxPOS2	M24	Addr3	R26	D1	
F5	TxCLK10	J23	RxCLK2	M25	AVDD	T1	DS3Clk	
F22	TxCLK0	J24	RLOS4	M26	Addr6	T2	AGND	
F23	RxNEG/LCV0	J25	CLKOUT4	N1	DMO3	Т3	RxNEG/LCV7	
F24	RxNEG/LCV2	J26	Pmode	N2	RESET	T4	RxCLK7	
F25	DVDD	K1	AVDD	N3	DMO0	T5	RxPOS7	
F26	DGND	K2	DMO10	N4	DMO1	T22	RxPOS5	
G1	TxCLK6	K3	RxCLK6	N5	DMO2	T23	RxCLK5	
G2	TxPOS6	K4	CLKOUT8	N22	WR	T24	RxNEG/LCV5	
G3	RxPOS8	K5	RLOL8	N23	RD	T25	AVDD	
G4	RLOS8	K22	RLOL2	N24	CS	T26	D2	
G5	RLOL10	K23	CLKOUT2	N25	RDY	U1	STS-1Clk/12M	
G22	RLOL0	K24	RxCLK4	N26	Addr7	U2	AGND	
G23	RLOS2	K25	Addr0	P1	DGND	U3	RLOS7	
G24	RxPOS2	K26	Addr4	P2	DVDD	U4	RxNEG/LCV9	
G25	TxPOS4	L1	AGND	P3	TEST	U5	RLOL9	
G26	TxCLK4	L2	DMO5	P4	TxON	U22	RLOL3	
H1	DGND	L3	RLOL6	P5	DVDD	U23	RxNEG/LCV3	
H2	DVDD	L4	RxNEG/LCV6	P22	D0	U24	RLOS5	
H3	TxNEG6	L5	RxPOS6	P23	DGND	U25	AGND	
H4	TxNEG8	L22	RxPOS4	P24	PCLK	U26	D3	
H5	TxCLK8	L23	RxNEG/LCV4	P25	DVDD	V1	DGND	
H22	TxCLK2	L24	RLOL4	P26	ĪNT	V2	CLKOUT7	
H23	TxNEG2	L25	AGND	R1	E3Clk	V3	DVDD	
H24	TxNEG4	L26	Addr5	R2	DGND	V4	RxCLK9	
H25	DVDD	M1	DMO4	R3	AGND	V5	DGND	

### TWELVE CHANNEL E3/DS3/STS-1 LINE INTERFACE UNIT

TABLE 1: LIST BY PIN NUMBER		TABL	BLE 1: LIST BY PIN NUMBER		TABLE 1: LIST BY PIN NUMBER		TABLE 1: LIST BY PIN NUMBER	
Pin	PIN NAME	Pin	PIN NAME	PIN	PIN NAME	Pin	PIN NAME	
V22	DGND	AA24	RLOS3	AC4	MRing11	AD10	AGND	
V23	RxCLK3	AA25	TxCLK5	AC5	RVDD11	AD11	TTip7	
V24	DVDD	AA26	TxPOS5	AC6	DGND	AD12	DVDD	
V25	CLKOUT5	AB1	RLOL11	AC7	DGND	AD13	RRing7	
V26	DGND	AB2	TxNEG11	AC8	MRing9	AD14	DVDD	
W1	DVDD	AB3	TxPOS11	AC9	RGND9	AD15	AGND	
W2	RLOL7	AB4	TDI	AC10	MRing7	AD16	TTip5	
W3	CLKOUT9	AB5	TCK	AC11	DGND	AD17	AGND	
W4	TxNEG9	AB6	AVDD	AC12	DGND	AD18	RRing3	
W5	CLKOUT11	AB7	AGND	AC13	RTip7	AD19	AGND	
W22	CLKOUT1	AB8	MTip9	AC14	DGND	AD20	TTip3	
W23	TxNEG3	AB9	AVDD	AC15	MTip5	AD21	AGND	
W24	CLKOUT3	AB10	AGND	AC16	DGND	AD22	RRing1	
W25	RLOL5	AB11	MTip7	AC17	AGND	AD23	MTip1	
W26	DVDD	AB12	RVDD7	AC18	RVDD3	AD24	TRing1	
Y1	TxNEG7	AB13	RGND7	AC19	MTip3	AD25	RLOS1	
Y2	DGND	AB14	RGND5	AC20	DGND	AD26	RxPOS1	
Y3	RxPOS9	AB15	RVDD5	AC21	AGND	AE1	AGND	
Y4	TxCLK9	AB16	MRing5	AC22	RVDD1	AE2	TDO	
Y5	DVDD	AB17	AGND	AC23	MRing1	AE3	TRing11	
Y22	DVDD	AB18	AVDD	AC24	DGND	AE4	TVDD11	
Y23	TxCLK3	AB19	MRing3	AC25	RxCLK1	AE5	RTip11	
Y24	RxPOS3	AB20	AGND	AC26	RxNEG/LCV1	AE6	TGND9	
Y25	DGND	AB21	AVDD	AD1	RxPOS11	AE7	TRing9	
Y26	TxNEG5	AB22	AGND	AD2	RLOS11	AE8	DGND	
AA1	TxPOS7	AB23	TMS	AD3	TTip11	AE9	RTip9	
AA2	TxCLK7	AB24	TxPOS1	AD4	MTip11	AE10	TVDD7	
AA3	RLOS9	AB25	TxNEG1	AD5	RRing11	AE11	TRing7	
AA4	TxPOS9	AB26	RLOL1	AD6	DVDD	AE12	AGND	
AA5	TxCLK11	AC1	RxNEG/LCV11	AD7	TTip9	AE13	AGND	
AA22	TxCLK1	AC2	RxCLK11	AD8	AGND	AE14	RRing5	
AA23	TxPOS3	AC3	DGND	AD9	RRing9	AE15	TVDD5	





TABLE 1: LIST BY PIN NUMBER

TABLE 1: LIST BY PIN NUMBER

Pin	PIN NAME
AE16	TRing5
AE17	DGND
AE18	RTip3
AE19	TVDD3
AE20	TRing3
AE21	DGND
AE22	RTip1
AE23	TVDD1
AE24	TTip1
AE25	TRST
AE26	AGND
AF1	AGND
AF2	AGND
AF3	DVDD
AF4	TGND11
AF5	RGND11
AF6	TVDD9
AF7	DVDD
AF8	DVDD
AF9	RVDD9
AF10	TGND7
AF11	DVDD
AF12	AVDD
AF13	AVDD
AF14	RTip5
AF15	TGND5
AF16	DVDD
AF17	DVDD
AF18	RGND3
AF19	TGND3
AF20	DVDD
AF21	DVDD

PIN	PIN NAME
AF22	RGND1
AF23	TGND1
AF24	DVDD
AF25	AGND
AF26	AGND

### **FUNCTIONAL DESCRIPTION**

The XRT73R12 is a twelve channel fully integrated Line Interface Unit featuring EXAR's R3 Technology (Reconfigurable, Relayless Redundancy) for E3/DS3/STS-1 applications. The LIU incorporates 12 independent Receivers and Transmitters in a single 420 Lead TBGA package. Each channel can be independently programmed to support E3, DS-3 or STS-1 line rates using one input clock reference of 12.288MHz in Single Frequency Mode (SFM). The LIU is responsible for providing the physical connection between a line interface and an aggregate mapper or framing device. Along with the analog-to-digital processing, the LIU offers monitoring and diagnostic features to help optimize network design implementation. A key characteristic within the network topology is Automatic Protection Switching (APS). EXAR's proven expertise in providing redundany solutions has paved the way for R<sup>3</sup> Technology.

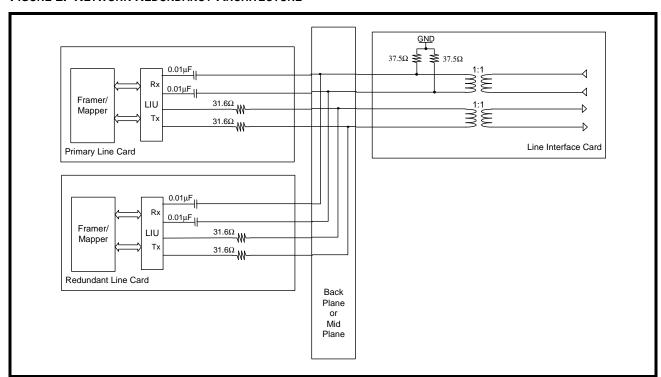
## 1.0 R<sup>3</sup> TECHNOLOGY (RECONFIGURABLE, RELAYLESS REDUNDANCY)

Redundancy is used to introduce reliability and protection into network card design. The redundant card in many cases is an exact replicate of the primary card, such that when a failure occurs the network processor can automatically switch to the backup card. EXAR's R<sup>3</sup> technology has re-defined E3/DS-3/STS-1 LIU design for 1:1 and 1+1 redundancy applications. Without relays and one Bill of Materials, EXAR offers multi-port, integrated LIU solutions to assist high density aggregate applications and framing requirements with reliability. The following section can be used as a reference for implementing R<sup>3</sup> Technology with EXAR's world leading line interface units.

#### 1.1 **Network Architecture**

A common network design that supports 1:1 or 1+1 redundancy consists of N primary cards along with N backup cards that connect into a mid-plane or back-plane architecture without transformers installed on the network cards. In addition to the network cards, the design has a line interface card with one source of transformers, connectors, and protection components that are common to both network cards. With this design, the bill of materials is reduced to the fewest amount of components. See Figure 2, for a simplified block diagram of a typical redundancy design.

FIGURE 2. NETWORK REDUNDANCY ARCHITECTURE



### 2.0 CLOCK SYNTHESIZER

The LIU uses a flexible user interface for accepting clock references to generate the internal master clocks used to drive the LIU. The reference clock used to supply the microprocessor timing is generated from the DS-3 or SFM clock input. Therefore, if the chip is configured for STS-1 only or E3 only, then the DS-3 input pin must be connected to the STS-1 pin or E3 pin respectively. In DS-3 mode or when SFM is used, the STS-1 and E3 input pins can be left unconnected. If SFM is enabled by pulling the SFM\_EN pin "High", 12.288MHz is the only clock reference necessary to generate DS-3, E3, or STS-1 line rates and the microprocessor timing. A simplified block diagram of the clock synthesizer is shown in Figure 3. Reference clock performance specifications can be found on Table 2 below.

FIGURE 3. SIMPLIFIED BLOCK DIAGRAM OF THE INPUT CLOCK CIRCUITRY DRIVING THE MICROPROCESSOR

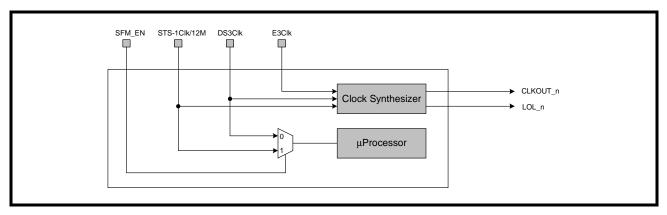


TABLE 2: REFERENCE CLOCK PERFORMANCE SPECIFICATIONS

SYMBOL	PARAMETER	Min	Түр	MAX	Units
REF <sub>DUTY</sub>	Reference Clock Duty Cycle	40		60	%
REF <sub>E3</sub>	E3 Reference Clock Frequency Tolerance <sup>1</sup>	-20		+20	ppm
REF <sub>DS3</sub>	DS3 Reference Clock Frequency Tolerance <sup>1</sup>	-20		+20	ppm
REF <sub>STS1</sub>	STS-1 Reference Clock Frequency Tolerance <sup>1</sup>	-20		+20	ppm
REF <sub>SFM</sub>	SFM Reference Clock Frequency Tolerance <sup>1</sup>	-20		+20	ppm
t <sub>RISE_REFCLK</sub>	Reference Clock Rise Time (10% to 90%)			5	ns
t <sub>FALL_REFCLK</sub>	Reference Clock Fall Time (90% to 10%)			5	ns
CLK <sub>JIT</sub>	Reference Clock Jitter Stability <sup>2</sup>			0.005	UI <sub>p2p</sub>

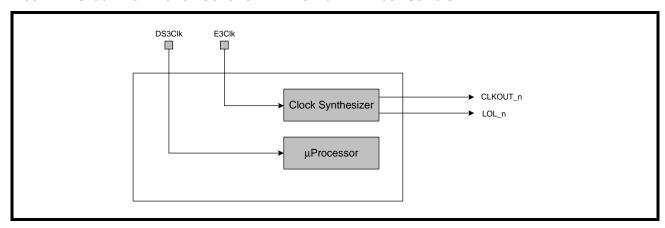
### Notes:

- 1. Required to meet Bellcore GR-499 specification on frequency stability requirements. However, the LIU can functionally operate with ±100 ppm without meeting the required specifications.
- 2. Reference clock jitter limits are required for the transmit output to meet ITU-T and Bellcore system level jitter requirements.

#### 2.1 **Clock Distribution**

Network cards that are designed to support multiple line rates which are not configured for single frequency mode should ensure that a clock is applied to the DS3Clk input pin. For example: If the network card being supplied to an ISP requires E3 only, the DS-3 input clock reference is still necessary to provide read and write access to the internal microprocessor. Therefore, the E3 mode requires two input clock references. If however, multiple line rates will not be supported, i.e. E3 only, then the DS3Clk input pin may be hard wire connected to the E3Clk input pin.

FIGURE 4. CLOCK DISTRIBUTION CONGIFURED IN E3 MODE WITHOUT USING SFM



**Note:** For one input clock reference, the single frequency mode should be used.

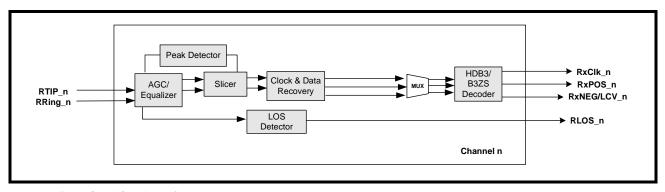
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### IWELVE CHANNEL E3/D33/313-1 LINE INTERFACE

### 3.0 THE RECEIVER SECTION

The receiver is designed so that the LIU can recover clock and data from an attenuated line signal caused by cable loss or flat loss according to industry specifications. Once data is recovered, it is processed and presented at the receiver outputs according to the format chosen to interface with a Framer/Mapper or ASIC. This section describes the detailed operation of various blocks within the receive path. A simplified block diagram of the receive path is shown in Figure 5.

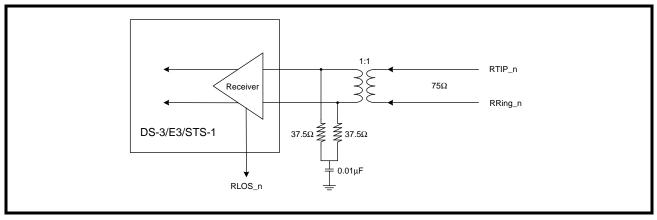
FIGURE 5. RECEIVE PATH BLOCK DIAGRAM



### 3.1 Receive Line Interface

Physical Layer devices are AC coupled to a line interface through a 1:1 transformer. The transformer provides isolation and a level shift by blocking the DC offset of the incoming data stream. The typical medium for the line interface is a  $75\Omega$  coxial cable. Whether using E3, DS-3 or STS-1, the LIU requires the same bill of materials, see Figure 6.

FIGURE 6. RECEIVE LINE INTERFACE CONNECTION



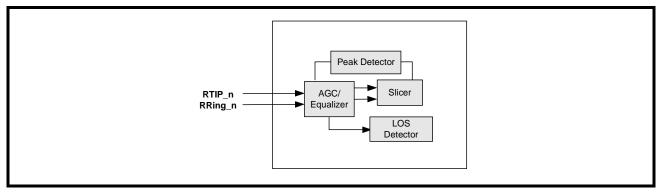
### 3.2 Adaptive Gain Control (AGC)

The Adaptive Gain Control circuit amplifies the incoming analog signal and compensates for the various flat losses and also for the loss at one-half symbol rate. The AGC has a dynamic range of 30 dB. The peak detector provides feedback to the equalizer before slicing occurs.

### 3.3 Receive Equalizer

The Equalizer restores the integrity of the signal and compensates for the frequency dependent attenuation of up to 900 feet of coaxial cable (1300 feet for E3). The Equalizer also boosts the high frequency content of the signal to reduce Inter-Symbol Interference (ISI) so that the slicer slices the signal at 50% of peak voltage to generate Positive and Negative data. The equalizer can be disabled by programming the appropriate register.

FIGURE 7. ACG/EQUALIZER BLOCK DIAGRAM



### 3.3.1 Recommendations for Equalizer Settings

The Equalizer has two gain settings to provide optimum equalization. In the case of normally shaped DS3/STS-1 pulses (pulses that meet the template requirements) that has been driven through 0 to 900 feet of cable, the Equalizer can be enabled. However, for square-shaped pulses such as E3 or for DS3/STS-1 high pulses (that does not meet the pulse template requirements), it is recommended that the Equalizer be disabled for cable length less than 300 feet. This would help to prevent over-equalization of the signal and thus optimize the performance in terms of better jitter transfer characteristics. The Equalizer also contains an additional 20 dB gain stage to provide the line monitoring capability (Receive Monitor Mode) of the resistively attenuated signals which may have 20dB flat loss. The equalizer and the equalizer gain mode can be enabled by programming the appropriate register. However, enabling the equalizer gain mode (Receive Monitor Mode) suppresses the internal LOS circuitry and LOS will never assert nor LOS be declared when operating with Receive Monitor Mode enabled.

**Note:** The results of extensive testing indicate that even when the Equalizer was enabled, regardless of the cable length, the integrity of the E3 signal was restored properly over 0 to 12 dB cable loss at Industrial Temperature.

### 3.4 Clock and Data Recovery

The Clock and Data Recovery Circuit extracts the embedded clock, RxClk\_n from the sliced digital data stream and provides the retimed data to the B3ZS (HDB3) decoder. The Clock Recovery PLL can be in one of the following two modes:

### 3.4.1 Data/Clock Recovery Mode

In the presence of input line signals on the RTIP\_n and RRing\_n input pins and when the frequency difference between the recovered clock signal and the reference clock signal is less than 0.5%, the clock that is output on the RxClk n out pins is the Recovered Clock signal.

### 3.4.2 Training Mode

In the absence of input signals at RTIP\_n and RRing\_n pins, or when the frequency difference between the recovered line clock signal and the reference clock applied on the ExClk\_n input pins exceed 0.5%, a Loss of Lock condition is declared by toggling RLOL\_n output pin "High" or setting the RLOL\_n bit to "1" in the control register. Also, the clock output on the RxClk\_n pins are the same as the reference channel clock.

### 3.5 LOS (Loss of Signal) Detector

### 3.5.1 DS3/STS-1 LOS Condition

A Digital Loss of SIgnal (DLOS) condition occurs when a string of 175 ± 75 consecutive zeros occur on the line. When the DLOS condition occurs, the DLOS\_n bit is set to "1" in the status control register. DLOS condition is cleared when the detected average pulse density is greater than 33% for 175 ± 75 pulses. Analog Loss of Signal (ALOS) condition occurs when the amplitude of the incoming line signal is below the threshold as shown in the Table 3. The status of the ALOS condition is reflected in the ALOS\_n status control register. RLOS is the logical OR of the DLOS and ALOS states. When the RLOS condition occurs the RLOS\_n output pin is toggled "High" and the RLOS\_n bit is set to "1" in the status control register.

TABLE 3: THE ALOS (ANALOG LOS) DECLARATION AND CLEARANCE THRESHOLDS FOR A GIVEN SETTING OF REQEN (DS3 AND STS-1 APPLICATIONS)

APPLICATION	REQEN SETTING	SIGNAL LEVEL TO DECLARE ALOS DEFECT	SIGNAL LEVEL TO CLEAR ALOS DEFECT
DS3	0	< 41mVpk	> 102mVpk
	1	< 52mVpk	> 117mVpk
STS-1	0	< 51mVpk	> 114mVpk
	1	< 58mVpk	> 133mVpk

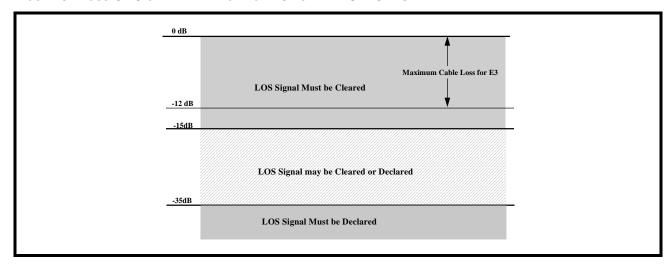
### 3.5.2 Disabling ALOS/DLOS Detection

For debugging purposes it is useful to disable the ALOS and/or DLOS detection. Writing a "1" to both ALOSDIS\_n and DLOSDIS\_n bits disables the LOS detection on a per channel basis.

### 3.5.3 E3 LOS Condition:

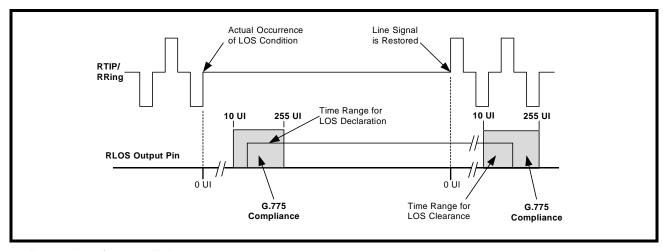
If the level of incoming line signal drops below the threshold as described in the ITU-T G.775 standard, the LOS condition is detected. Loss of signal is defined as no transitions for 10 to 255 consecutive zeros. No transitions is defined as a signal level between 15 and 35 dB below the normal. This is illustrated in Figure 8. The LOS condition is cleared within 10 to 255 UI after restoration of the incoming line signal. Figure 9 shows the LOS declaration and clearance conditions.

FIGURE 8. LOSS OF SIGNAL DEFINITION FOR E3 AS PER ITU-T G.775



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FIGURE 9. LOSS OF SIGNAL DEFINITION FOR E3 AS PER ITU-T G.775.



#### 3.5.4 **Interference Tolerance**

For E3 mode, ITU-T G.703 Recommendation specifies that the receiver be able to recover error free clock and data in the presence of a sinusoidal interfering tone signal. For DS3 and STS-1 modes, the same recommendation is being used. Figure 10 shows the configuration to test the interference margin for DS3/ STS1. Figure 11 shows the set up for E3.

FIGURE 10. INTERFERENCE MARGIN TEST SET UP FOR DS3/STS-1

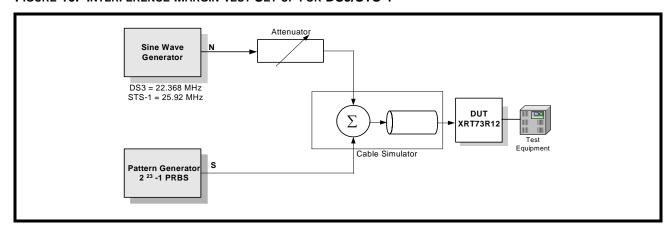


FIGURE 11. INTERFERENCE MARGIN TEST SET UP FOR E3.

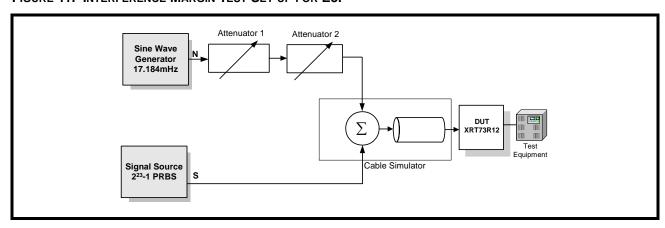


TABLE 4: INTERFERENCE MARGIN TEST RESULTS

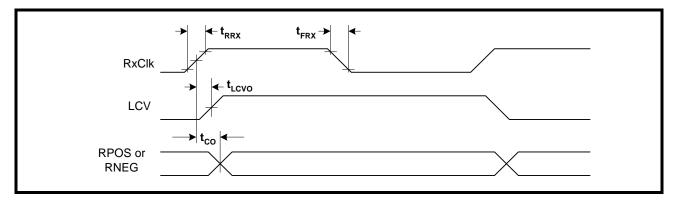
Mode	CABLE LENGTH (ATTENUATION)	INTERFERENCE TOLERANCE
		Equalizer "IN"
E3	0 dB	-17 dB
	12 dB	-14 dB
	0 feet	-15 dB
DS3	225 feet	-15 dB
	450 feet	-14 dB
	0 feet	-15 dB
STS-1	225 feet	-14 dB
	450 feet	-14 dB

### 3.5.5 Muting the Recovered Data with LOS condition:

When the LOS condition is declared, the clock recovery circuit locks into the reference clock applied to the internal master clock outputs this clock onto the RxClk\_n output pin. The data on the RxPOS\_n and RxNEG\_n pins can be forced to zero by setting the LOSMUT\_n bits in the individual channel control register to "1".

Note: When the LOS condition is cleared, the recovered data is output on RxPOS\_n and RxNEG\_n pins.

FIGURE 12. RECEIVER DATA OUTPUT AND CODE VIOLATION TIMING



### REV. 1.0.3

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS
RxClk	Duty Cycle	45	50	55	%
	RxClk Frequency				
	E3		34.368		MHz
	DS-3		44.736		MHz
	STS-1		51.84		MHz
t <sub>RRX</sub>	RxClk rise time (10% o 90%)		2	4	ns
t <sub>FRX</sub>	RxClk falling time (10% to 90%)		2	4	ns
t <sub>CO</sub>	RxClk to RPOS/RNEG delay time			4	ns
t <sub>LCVO</sub>	RxClk to rising edge of LCV output delay		2.5		ns

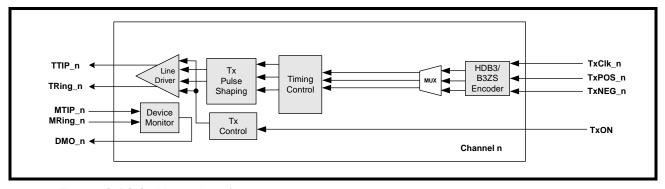
### 3.6 B3ZS/HDB3 Decoder

The decoder block takes the output from the clock and data recovery block and decodes the B3ZS (for DS3 or STS-1) or HDB3 (for E3) encoded line signal and detects any coding errors or excessive zeros in the data stream. Whenever the input signal violates the B3ZS or HDB3 coding sequence for bipolar violation or contains three (for B3ZS) or four (for HDB3) or more consecutive zeros, an active "High" pulse is generated on the RLCV\_n output pins to indicate line code violation.

# 4.0 THE TRANSMITTER SECTION

The transmitter is designed so that the LIU can accept serial data from a local device, encode the data properly, and then output an analog pulse according to the pulse shape chosen in the appropriate registers. This section describes the detailed operation of various blocks within the transmit path. A simplified block diagram of the transmit path is shown in Figure 13.

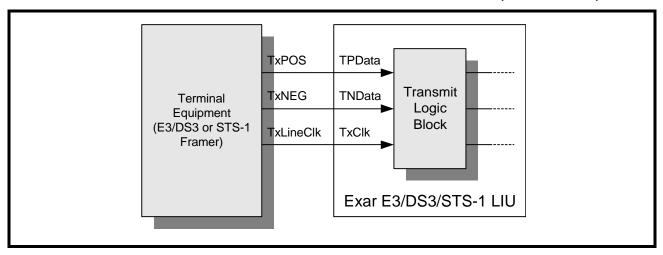
FIGURE 13. TRANSMIT PATH BLOCK DIAGRAM



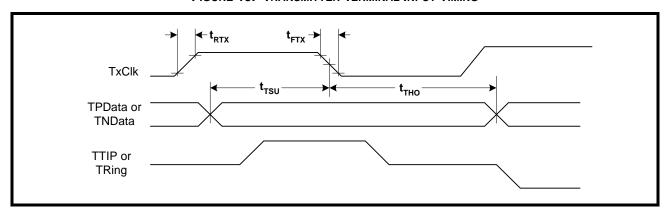
### 4.1 Transmit Digital Input Interface

The method for applying data to the transmit inputs of the LIU is a serial interface consisting of TxClk, TxPOS, and TxNEG. For single rail mode, only TxClk and TxPOS are necessary for providing the local data from a Framer device or ASIC. Data can be sampled on either edge of the input clock signal by programming the appropriate register. A typical interface is shown in Figure 14.

FIGURE 14. TYPICAL INTERFACE BETWEEN TERMINAL EQUIPMENT AND THE XRT73R12 (DUAL-RAIL DATA)

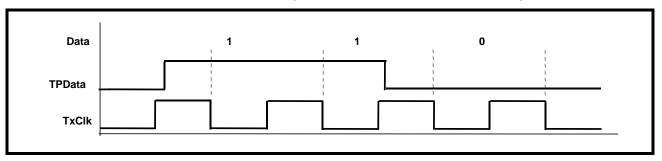






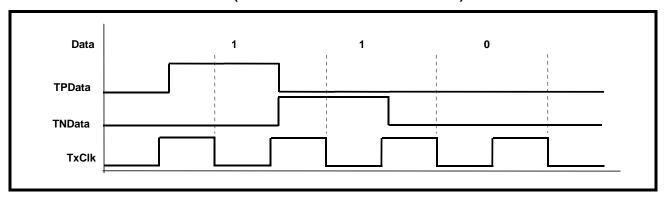
SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS
TxClk	Duty Cycle	30	50	70	%
	TxClk Frequency				
	E3		34.368		MHz
	DS-3		44.736		MHz
	STS-1		51.84		MHz
t <sub>RTX</sub>	TxClk Rise Time (10% to 90%)			4	ns
t <sub>FTX</sub>	TxClk Fall Time (10% to 90%)			4	ns
t <sub>TSU</sub>	TPData/TNData to TxClk falling set up time	3			ns
t <sub>THO</sub>	TPData/TNData to TxClk falling hold time	3			ns

FIGURE 16. SINGLE-RAIL OR NRZ DATA FORMAT (ENCODER AND DECODER ARE ENABLED)



REV. 1.0.3

FIGURE 17. DUAL-RAIL DATA FORMAT (ENCODER AND DECODER ARE DISABLED)



### 4.2 Transmit Clock

The Transmit Clock applied via TxClk\_n pins, for the selected data rate (for E3 = 34.368 MHz, DS3 = 44.736 MHz or STS-1 = 51.84 MHz), is duty cycle corrected by the internal PLL circuit to provide a 50% duty cycle clock to the pulse shaping circuit. This allows a 30% to 70% duty cycle Transmit Clock to be supplied.

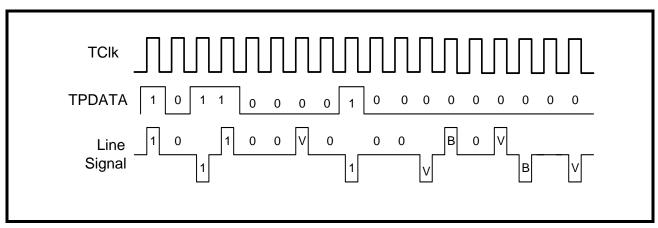
### 4.3 B3ZS/HDB3 ENCODER

When the Single-Rail (NRZ) data format is selected, the Encoder Block encodes the data into either B3ZS format (for either DS3 or STS-1) or HDB3 format (for E3).

### 4.3.1 B3ZS Encoding

An example of B3ZS encoding is shown in Figure 18. If the encoder detects an occurrence of three consecutive zeros in the data stream, it is replaced with either B0V or 00V, where 'B' refers to Bipolar pulse that is compliant with the Alternating polarity requirement of the AMI (Alternate Mark Inversion) line code and 'V' refers to a Bipolar Violation (e.g., a bipolar pulse that violates the AMI line code). The substitution of B0V or 00V is made so that an odd number of bipolar pulses exist between any two consecutive violation (V) pulses. This avoids the introduction of a DC component into the line signal.

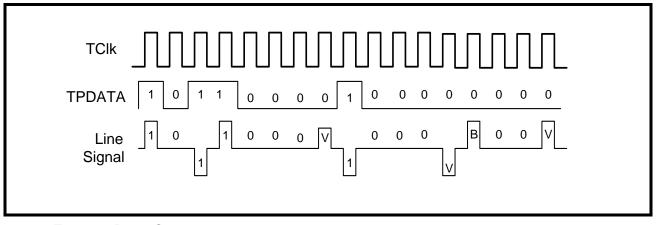
FIGURE 18. B3ZS ENCODING FORMAT



### 4.3.2 HDB3 Encoding

An example of the HDB3 encoding is shown in Figure 19. If the HDB3 encoder detects an occurrence of four consecutive zeros in the data stream, then the four zeros are substituted with either 000V or B00V pattern. The substitution code is made in such a way that an odd number of pulses exist between any consecutive V pulses. This avoids the introduction of DC component into the analog signal.

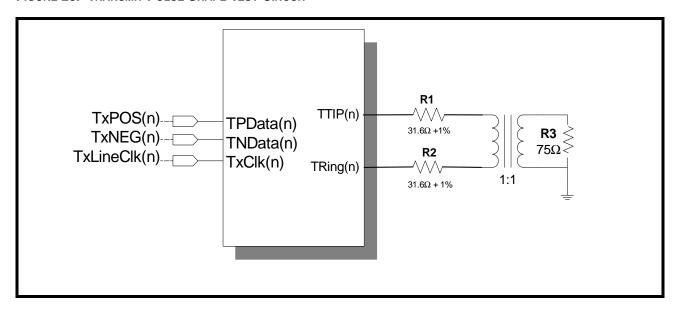
FIGURE 19. HDB3 ENCODING FORMAT



### 4.4 TRANSMIT PULSE SHAPER

The Transmit Pulse Shaper converts the B3ZS encoded digital pulses into a single analog Alternate Mark Inversion (AMI) pulse that meets the industry standard mask template requirements for STS-1 and DS3. For E3 mode, the pulse shaper converts the HDB3 encoded pulses into a single full amplitude square shaped pulse with very little slope. The Pulse Shaper Block also includes a Transmit Build Out Circuit, which can either be disabled or enabled by setting the TxLEV\_n bit to "1" or "0" in the control register. For DS3/STS-1 rates, the Transmit Build Out Circuit is used to shape the transmit waveform that ensures that transmit pulse template requirements are met at the Cross-Connect system. The distance between the transmitter output and the Cross-Connect system can be between 0 to 450 feet. For E3 rate, since the output pulse template is measured at the secondary of the transformer and since there is no Cross-Connect system pulse template requirements, the Transmit Build Out Circuit is always disabled. The differential line driver increases the transmit waveform to appropriate level and drives into the 75 $\Omega$  load as shown in Figure 20.

FIGURE 20. TRANSMIT PULSE SHAPE TEST CIRCUIT



### 4.4.1 Guidelines for using Transmit Build Out Circuit

If the distance between the transmitter and the DSX3 or STSX-1, Cross-Connect system, is less than 225 feet, enable the Transmit Build Out Circuit by setting the TxLEV\_n control bit to "0". If the distance between the transmitter and the DSX3 or STSX-1 is greater than 225 feet, disable the Transmit Build Out Circuit.

### 4.5 E3 line side parameters

The XRT73R12 line output at the transformer output meets the pulse shape specified in ITU-T G.703 for 34.368 Mbits/s operation. The pulse mask as specified in ITU-T G.703 for 34.368 Mbits/s is shown in Figure 21.

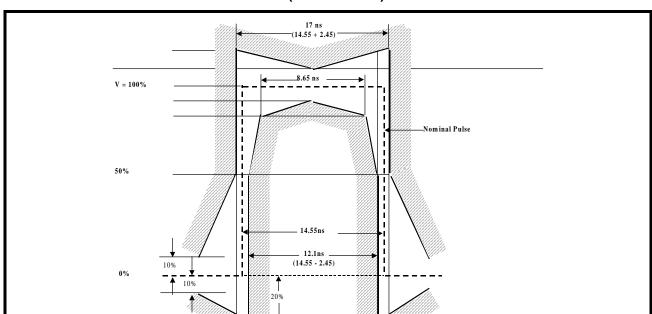


FIGURE 21. PULSE MASK FOR E3 (34.368 MBITS/S) INTERFACE AS PER ITU-T G.703

## TABLE 5: E3 TRANSMITTER LINE SIDE OUTPUT AND RECEIVER LINE SIDE INPUT SPECIFICATIONS

PARAMETER	MIN	TYP	MAX	UNITS		
TRANSMITTER LINE SIDE OUTPUT CHARACTERISTICS						
Transmit Output Pulse Amplitude	0.90	1.00	1.10	$V_{pk}$		
(Measured at secondary of the transformer)						
Transmit Output Pulse Amplitude Ratio	0.95	1.00	1.05			
Transmit Output Pulse Width	12.5	14.55	16.5	ns		
Transmit Intrinsic Jitter		0.02	0.05	Ul <sub>PP</sub>		
RECEIVER LINE SIDE INPUT CHARACTERISTICS						
Receiver Sensitivity (length of cable)	900	1200		feet		
Interference Margin	-20	-14		dB		
Jitter Tolerance @ Jitter Frequency 800KHz	0.15	0.28		Ul <sub>PP</sub>		
Signal level to Declare Loss of Signal			-35	dB		
Signal Level to Clear Loss of Signal	-15			dB		
Occurence of LOS to LOS Declaration Time	10		255	UI		
Termination of LOS to LOS Clearance Time	10		255	UI		

**Note:** The above values are at  $TA = 25^{\circ}C$  and  $V_{DD} = 3.3 \text{ V} \pm 5\%$ .

FIGURE 22. BELLCORE GR-253 CORE TRANSMIT OUTPUT PULSE TEMPLATE FOR SONET STS-1 APPLICATIONS

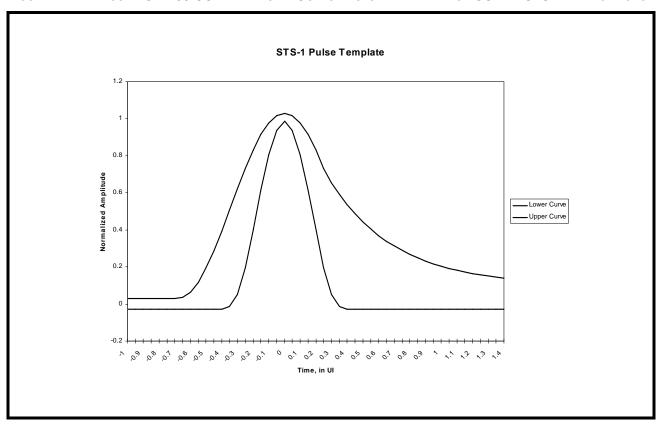


TABLE 6: STS-1 PULSE MASK EQUATIONS

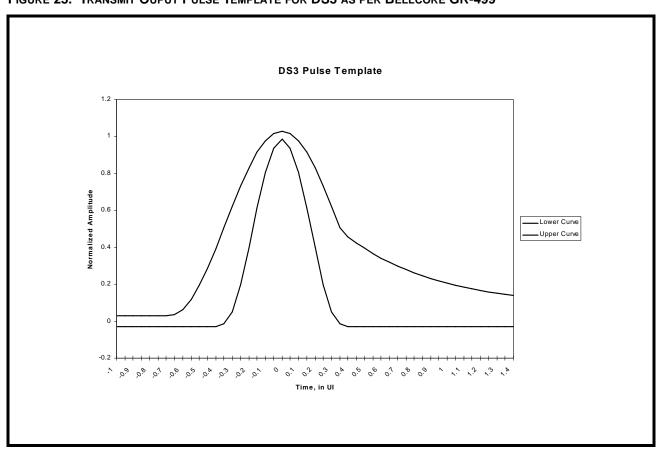
TIME IN UNIT INTERVALS	Normalized Amplitude				
LOWER CURVE					
-0.85 ≤ T ≤ -0.38	- 0.03				
-0.38 ≤ T ≤ 0.36	$0.5 \left[ 1 + \sin \left\{ \frac{\pi}{2} \left( 1 + \frac{T}{0.18} \right) \right\} \right] - 0.03$				
$0.36 \le T \le 1.4$	- 0.03				
UPPER	CURVE				
-0.85 ≤ T ≤ -0.68	0.03				
-0.68 ≤ T ≤ 0.26	$0.5 \left[ 1 + \sin \left\{ \frac{\pi}{2} \left( 1 + \frac{T}{0.34} \right) \right\} \right] + 0.03$				
0.26 ≤ T ≤ 1.4	0.1 + 0.61 x e <sup>-2.4[T-0.26]</sup>				

TABLE 7: STS-1 TRANSMITTER LINE SIDE OUTPUT AND RECEIVER LINE SIDE INPUT SPECIFICATIONS (GR-253)

PARAMETER	Min	ТҮР	Max	Units	
Transmitter line side output characteristics					
Transmit Output Pulse Amplitude	0.65	0.75	0.90	$V_{pk}$	
(measured with TxLEV = 0)					
Transmit Output Pulse Amplitude	0.90	1.00	1.10	$V_{pk}$	
(measured with TxLEV = 1)					
Transmit Output Pulse Width	8.6	9.65	10.6	ns	
Transmit Output Pulse Amplitude Ratio	0.90	1.00	1.10		
Transmit Intrinsic Jitter		0.02	0.05	UI <sub>pp</sub>	
RECEIVER LINE SIDE INPUT CHARACT	ERISTICS				
Receiver Sensitivity (length of cable)	900	1100		feet	
Jitter Tolerance @ Jitter Frequency 400 KHz	0.15			UI <sub>pp</sub>	
Signal Level to Declare Loss of Signal	Refer to Table 3				
Signal Level to Clear Loss of Signal	Refer to Table 3				

**NOTE:** The above values are at TA =  $25^{\circ}$ C and  $V_{DD} = 3.3 \text{ V} \pm 5\%$ .

FIGURE 23. TRANSMIT OUPUT PULSE TEMPLATE FOR DS3 AS PER BELLCORE GR-499





#### **TABLE 8: DS3 PULSE MASK EQUATIONS**

TIME IN UNIT INTERVALS	Normalized Amplitude
LOWE	R CURVE
-0.85 ≤ T ≤ -0.36	- 0.03
-0.36 ≤ T ≤ 0.36	$0.5 \left[ 1 + \sin \left\{ \frac{\pi}{2} \left( 1 + \frac{T}{0.18} \right) \right\} \right] - 0.03$
0.36 ≤ T ≤ 1.4	- 0.03
UPPE	R CURVE
-0.85 ≤ T ≤ -0.68	0.03
-0.68 ≤ T ≤ 0.36	$0.5 \left[ 1 + \sin \left\{ \frac{\pi}{2} \left( 1 + \frac{T}{0.34} \right) \right\} \right] + 0.03$
0.36 ≤ T ≤ 1.4	0.08 + 0.407 x e <sup>-1.84[T-0.36]</sup>

TABLE 9: DS3 TRANSMITTER LINE SIDE OUTPUT AND RECEIVER LINE SIDE INPUT SPECIFICATIONS (GR-499)

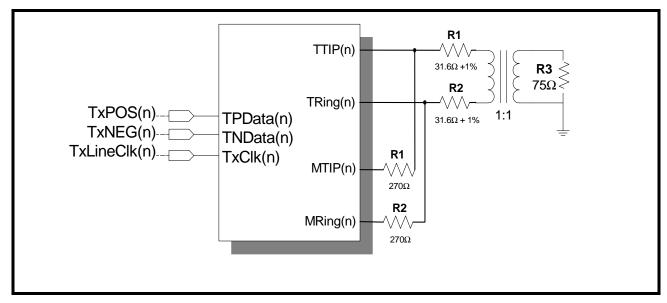
PARAMETER	Min	ТҮР	Max	Units	
TRANSMITTER LINE SIDE OUTPUT CHARACTERISTICS					
Transmit Output Pulse Amplitude (measured with TxLEV = 0)	0.65	0.75	0.85	$V_{pk}$	
Transmit Output Pulse Amplitude (measured with TxLEV = 1)	0.90	1.00	1.10	$V_{pk}$	
Transmit Output Pulse Width	10.10	11.18	12.28	ns	
Transmit Output Pulse Amplitude Ratio	0.90	1.00	1.10		
Transmit Intrinsic Jitter		0.02	0.05	UI <sub>pp</sub>	
RECEIVER LINE SIDE INPUT CHARACT	TERISTICS				
Receiver Sensitivity (length of cable)	900	1100		feet	
Jitter Tolerance @ 400 KHz (Cat II)	0.15			UI <sub>pp</sub>	
Signal Level to Declare Loss of Signal	Refer to Table 3				
Signal Level to Clear Loss of Signal	Refer to Table 3				

**Note:** The above values are at TA =  $25^{\circ}$ C and  $V_{DD} = 3.3V \pm 5\%$ .

#### 4.6 Transmit Drive Monitor

This feature is used for monitoring the transmit line for occurrence of fault conditions such as a short circuit on the line or a defective line driver. To activate this function, connect MTIP n pins to the TTIP n lines via a  $270\Omega$ resistor and MRing n pins to TRing n lines via  $270\Omega$  resistor as shown in Figure 24.

FIGURE 24. TRANSMIT DRIVER MONITOR SET-UP.



When the MTIP\_n and MRing\_n are connected to the TTIP\_n and TRing\_n lines, the drive monitor circuit monitors the line for transitions. The DMO n (Drive Monitor Output) will be asserted "Low" as long as the transitions on the line are detected via MTIP\_n and MRing\_n. If no transitions on the line are detected for 128 ± 32 TxClk n periods, the DMO n output toggles "High" and when the transitions are detected again, DMO n toggles "Low".

Note: The Drive Monitor Circuit is only for diagnostic purpose and does not have to be used to operate the transmitter.

#### 4.7 Transmitter Section On/Off

The transmitter section of each channel can either be turned on or off. To turn on the transmitter, set the input pin TxON to "High" and write a "1" to the TxON\_n control bit. When the transmitter is turned off, TTIP\_n and TRing\_n are tri-stated.

#### NOTES:

- 1. This feature provides support for Redundancy.
- If the XRT73R12 is configured in Host mode, to permit a system designed for redundancy to quickly shut-off the defective line card and turn on the back-up line card, writing a "1" to the TxON\_n control bits transfers the control to TxON pin.

#### 5.0 JITTER

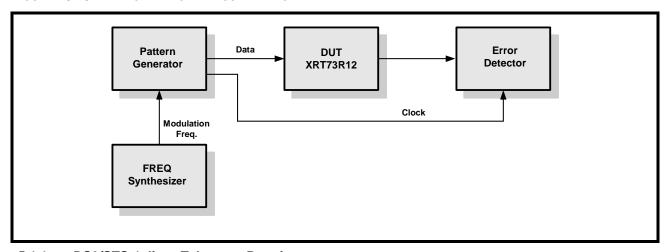
There are three fundamental parameters that describe circuit performance relative to jitter

- Jitter Tolerance
- Jitter Transfer
- Jitter Generation

#### 5.1 JITTER TOLERANCE

Jitter tolerance is a measure of how well a Clock and Data Recovery unit can successfully recover data in the presence of various forms of jitter. It is characterized by the amount of jitter required to produce a specified bit error rate. The tolerance depends on the frequency content of the jitter. Jitter Tolerance is measured as the jitter amplitude over a jitter spectrum for which the clock and data recovery unit achieves a specified bit error rate (BER). To measure the jitter tolerance as shown in Figure 25, jitter is introduced by the sinusoidal modulation of the serial data bit sequence. Input jitter tolerance requirements are specified in terms of compliance with jitter mask which is represented as a combination of points. Each point corresponds to a minimum amplitude of sinusoidal jitter at a given jitter frequency.

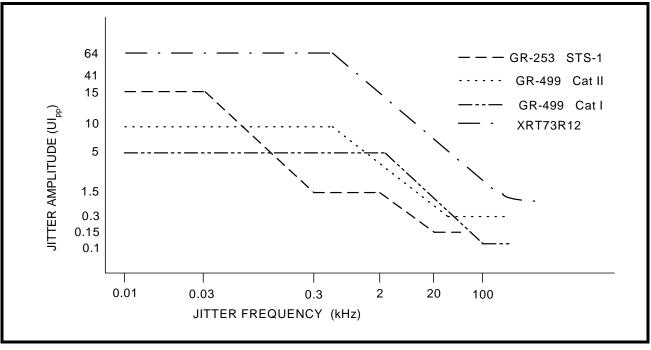
FIGURE 25. JITTER TOLERANCE MEASUREMENTS



#### 5.1.1 **DS3/STS-1 Jitter Tolerance Requirements**

Bellcore GR-499 CORE specifies the minimum requirement of jitter tolerance for Category I and Category II. The jitter tolerance requirement for Category II is the most stringent. Figure 26 shows the jitter tolerance curve as per GR-499 specification.

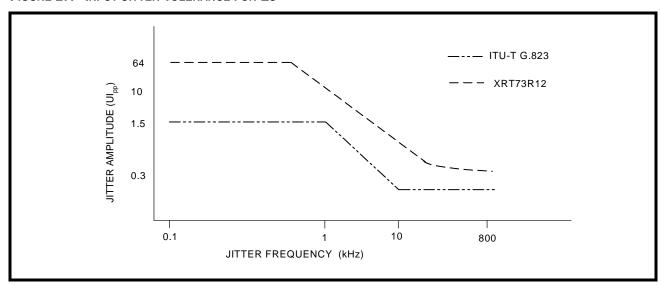
FIGURE 26. INPUT JITTER TOLERANCE FOR DS3/STS-1



#### 5.1.2 E3 Jitter Tolerance Requirements

ITU-T G.823 standard specifies that the clock and data recovery unit must be able to tolerate jitter up to certain specified limits. Figure 27 shows the tolerance curve.

FIGURE 27. INPUT JITTER TOLERANCE FOR E3



As shown in the Figures above, in the jitter tolerance measurement, the dark line indicates the minimum level of jitter that the E3/DS3/STS-1 compliant component must tolerate. Table 10 below shows the jitter amplitude versus the modulation frequency for various standards.

BIT RATE	STANDARD INPU		IPUT JITTER AMPLITUDE (UI <sub>P-P</sub> )		MODULATION FREQUENCY				
(KB/S)	OTANDARD	A1	A2	А3	F1(Hz)	F2(Hz)	F3(KHz)	F4(KHz)	F5(KHz)
34368	ITU-T G.823	1.5	0.15	-	100	1000	10	800	-
44736	GR-499 CORE Cat I	5	0.1	-	10	2.3k	60	300	-
44736	GR-499 CORE Cat II	10	0.3	-	10	669	22.3	300	-
51840	GR-253 CORE Cat II	15	1.5	0.15	10	30	300	2	20

#### 5.2 JITTER TRANSFER

Jitter Transfer function is defined as the ratio of jitter on the output relative to the jitter applied on the input versus frequency. There are two distinct characteristics in jitter transfer, jitter gain (jitter peaking) defined as the highest ratio above 0dB and jitter transfer bandwidth. The overall jitter transfer bandwidth is controlled by a low bandwidth loop, typically using a voltage-controlled crystal oscillator (VCXO).

The jitter transfer function is a ratio between the jitter output and jitter input for a component, or system often expressed in dB. A negative dB jitter transfer indicates the element removed jitter. A positive dB jitter transfer indicates the element added jitter. A zero dB jitter transfer indicates the element had no effect on jitter. Table 11 shows the jitter transfer characteristics and/or jitter attenuation specifications for various data rates:

TABLE 11: JITTER TRANSFER SPECIFICATION/REFERENCES

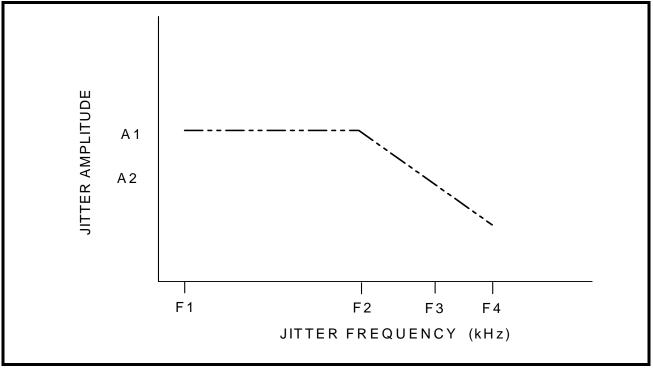
E3	DS3	STS-1
ETSI TBR-24	GR-499 CORE section 7.3.2 Category I and Category II	GR-253 CORE section 5.6.2.1

Note: The above specifications can be met only with a jitter attenuator that supports E3/DS3/STS-1 rates.

**TABLE 12: JITTER TRANSFER PASS MASKS** 

RATE (KBITS)	Mask	F1 (Hz)	F2 (Hz)	F3 (Hz)	F4 (ĸHz)	A1(dB)	A2(dB)
34368	G.823 ETSI-TBR-24	100	300	3к	800K	0.5	-19.5
44736	GR-499, Cat I GR-499, Cat II GR-253 CORE	10 10 10	10k 56.6k 40	- - -	15k 300k 15k	0.1 0.1 0.1	
51840	GR-253 CORE	10	40k	-	400k	0.1	-

FIGURE 28. JITTER TRANSFER REQUIREMENTS



#### 5.2.1 JITTER GENERATION

Jitter Generation is defined as the process whereby jitter appears at the output port of the digital equipment in the absence of applied input jitter. Jitter Generation is measured by sending jitter free data to the clock and data recovery circuit and measuring the amount of jitter on the output clock or the re-timed data. Since this is essentially a noise measurement, it requires a definition of bandwidth to be meaningful. The bandwidth is set according to the data rate. In general, the jitter is measured over a band of frequencies.

#### 6.0 DIAGNOSTIC FEATURES

#### 6.1 PRBS Generator and Detector

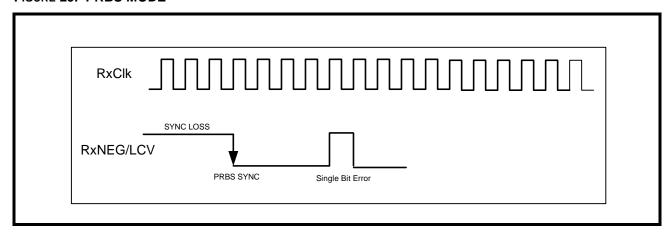
The XRT73R12 contains an on-chip Pseudo Random Binary Sequence (PRBS) generator and detector for diagnostic purpose. With the PRBSEN\_n bit = "1", the transmitter will send out PRBS of 2<sup>23</sup>-1 in E3 rate or 2<sup>15</sup>-1 in STS-1/DS3 rate. At the same time, the receiver PRBS detector is also enabled. When the correct PRBS pattern is detected by the receiver, the RNEG/LCV pin will go "Low" to indicate PRBS synchronization has been achieved. When the PRBS detector is not in sync the PRBSLS bit will be set to "1" and RNEG/LCV pin will go "High".

With the PRBS mode enabled, the user can also insert a single bit error by toggling "INSPRBS" bit. This is done by writing a "1" to INSPRBS bit. The receiver at RNEG/LCV pin will pulse "High" for one RxClk cycle for every bit error detected. Any subsequent single bit error insertion must be done by first writing a "0" to INSPRBS bit and followed by a "1".

Figure 29 shows the status of RNEG/LCV pin when the XRT73R12 is configured in PRBS mode.

**Note:** In PRBS mode, the device is forced to operate in Single-Rail Mode.

#### FIGURE 29. PRBS MODE



#### 6.2 **LOOPBACKS**

The XRT73R12 offers three loopback modes for diagnostic purposes. The loopback modes are selected via the RLB n and LLB n bits n the Channel control registers select the loopback modes.

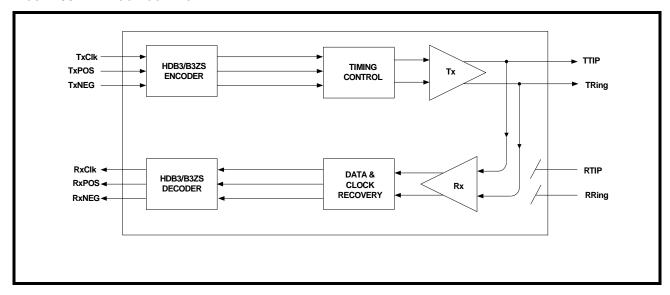
#### 6.2.1 **ANALOG LOOPBACK**

In this mode, the transmitter outputs TTIP\_n and TRing\_n are internally connected to the receiver inputs RTIP\_n and RRing\_n as shown in Figure 30. Data and clock are output at RxClk\_n, RxPOS\_n and RxNEG\_n pins for the corresponding transceiver. Analog loopback exercises most of the functional blocks of the device.

#### NOTES:

- 1. In the Analog loopback mode, data is also output via TTIP\_n and TRing\_n pins.
- 2. Signals on the RTIP\_n and RRing\_n pins are ignored during analog loopback.

#### FIGURE 30. ANALOG LOOPBACK

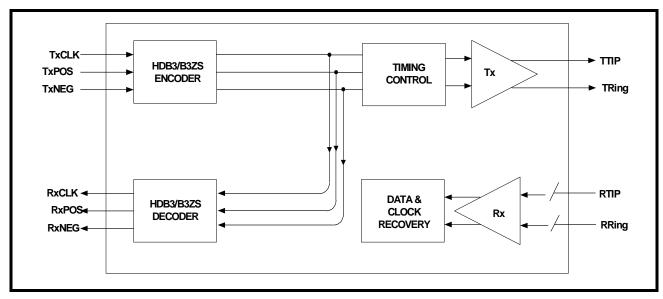


#### TWEEVE CHARMEE ES/DOS/STO-T LINE INTERTACT

#### 6.2.2 DIGITAL LOOPBACK

When the Digital Loopback is selected, the transmit clock TxClk\_n and transmit data inputs (TxPOS\_n & TxNEG\_n are looped back and output onto the RxClk\_n, RxPOS\_n and RxNEG\_n pins as shown in Figure 31.

FIGURE 31. DIGITAL LOOPBACK

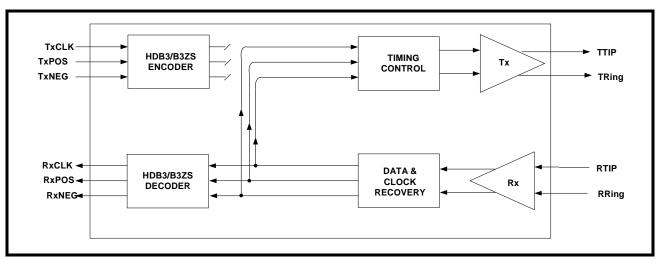


#### 6.2.3 REMOTE LOOPBACK

With Remote loopback activated as shown in Figure 32, the receive data on RTIP and RRing is looped back after the Data and Clock Recovery to the transmit path using RxClk as transmit timing. The receive data is also output via the RxPOS and RxNEG pins.

Note: Input signals on TxClk, TxPOS and TxNEG are ignored during Remote loopback.

FIGURE 32. REMOTE LOOPBACK

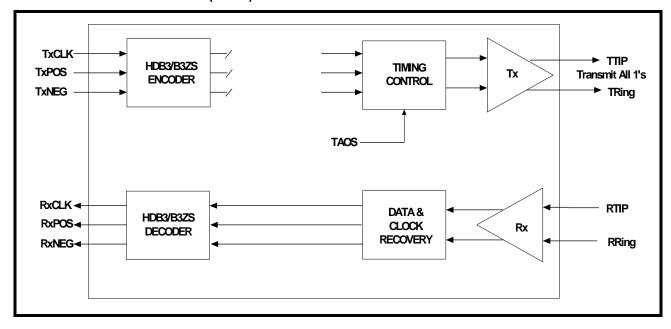




#### 6.3 TRANSMIT ALL ONES (TAOS)

Transmit All Ones (TAOS) can be set by setting the TAOS\_n control bits to "1" in the Channel control registers. When the TAOS is set, the Transmit Section generates and transmits a continuous AMI all "1's" pattern on TTIP\_n and TRing\_n pins. The frequency of this ones pattern is determined by TxClk\_n. the TAOS data path is shown in Figure 33. TAOS does not operate in Analog loopback or Remote loopback modes, however will function in Digital loopback mode.

FIGURE 33. TRANSMIT ALL ONES (TAOS)



#### 7.0 MICROPROCESSOR INTERFACE BLOCK

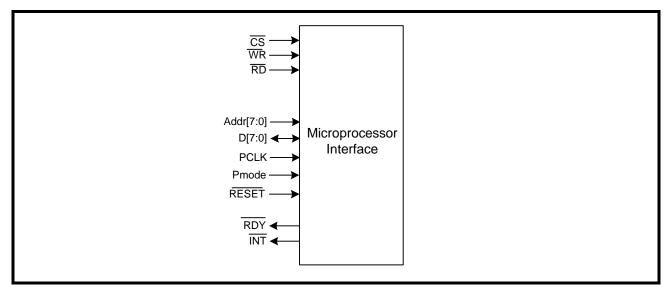
The Microprocessor Interface section supports communication between the local microprocessor (µP) and the LIU. The XRT73R12 supports a parallel interface asynchronously or synchronously timed to the LIU. The microprocessor interface is selected by the state of the Pmode input pin. Selecting the microprocessor interface mode is shown in Table 13.

TABLE 13: SELECTING THE MICROPROCESSOR INTERFACE MODE

PMODE	MICROPROCESSOR MODE
"Low"	Asynchronous Mode
"High"	Synchronous Mode

The local µP configures the LIU by writing data into specific addressable, on-chip Read/Write registers. The μP provides the signals which are required for a general purpose microprocessor to read or write data into these registers. The µP also supports polled and interrupt driven environments. A simplified block diagram of the microprocessor is shown in Figure 34.

FIGURE 34. SIMPLIFIED BLOCK DIAGRAM OF THE MICROPROCESSOR INTERFACE BLOCK



#### 7.1 THE MICROPROCESSOR INTERFACE BLOCK SIGNALS

The LIU may be configured into different operating modes and have its performance monitored by software through a standard microprocessor using data, address and control signals. These interface signals are described below in Table 14. The microprocessor interface can be configured to operate in Asynchronous mode or Synchronous mode.

TABLE 14: XRT73R12 MICROPROCESSOR INTERFACE SIGNALS

PIN NAME	Түре	DESCRIPTION
Pmode	I	Microprocessor Interface Mode Select Input pin This pin is used to specify the microprocessor interface mode.
D[7:0]	I/O	Bi-Directional Data Bus for register "Read" or "Write" Operations.
Addr[7:0]	I	Eight-Bit Address Bus Inputs The XRT73R12 LIU microprocessor interface uses a direct address bus. This address bus is provided to permit the user to select an on-chip register for Read/Write access.
<u>CS</u>	1	Chip Select Input This active low signal selects the microprocessor interface of the XRT73R12 LIU and enables Read/Write operations with the on-chip register locations.
RD	I	<b>Read Signal</b> This active low input functions as the read signal from the local μP. When this pin is pulled "Low" (if $\overline{CS}$ is "Low") the LIU is informed that a read operation has been requested and begins the process of the read cycle.
WR	1	<b>Write Signal</b> This active low input functions as the write signal from the local $\mu P$ . When this pin is pulled "Low" (if $\overline{CS}$ is "Low") the LIU is informed that a write operation has been requested and begins the process of the write cycle.
RDY	0	<b>Ready Output</b> This active low signal is provided by the LIU device. It indicates that the current read or write cycle is complete, and the LIU is waiting for the next command.
ĪNT	0	Interrupt Output This active low signal is provided by the LIU to alert the local mP that a change in alarm status has occured. This pin is Reset Upon Read (RUR) once the alarm status registers have been cleared.
RESET	I	Reset Input This active low input pin is used to Reset the LIU.

# 7.2 ASYNCHRONOUS AND SYNCHRONOUS DESCRIPTION

Whether the LIU is configured for Asynchronous or Synchronous mode, the following descriptions apply. The synchronous mode requires an input clock (PCLK) to be used as the microprocessor timing reference. Read and Write operations are described below.

#### Read Cycle (For Pmode = "0" or "1")

Whenever the local µP wishes to read the contents of a register, it should do the following.

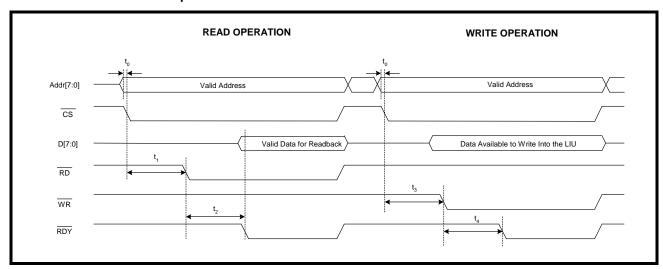
- 1. Place the address of the target register on the address bus input pins Addr[7:0].
- 2. While the  $\underline{\mu P}$  is placing this address value on the address bus, the address decoding circuitry should assert the CS pin of the LIU, by toggling it "Low". This action enables communication between the  $\mu P$  and the LIU microprocessor interface block.
- 3. Next, the  $\mu$ P should indicate that this current bus cycle is a Read operation by toggling the  $\overline{RD}$  input pin "Low". This action enables the bi-directional data bus output drivers of the LIU.
- **4.** After the  $\mu$ P toggles the Read signal "Low", the LIU will toggle the  $\overline{RDY}$  output pin "Low". The LIU does this to inform the  $\mu$ P that the data is available to be read by the  $\mu$ P, and that it is ready for the next command.
- 5. After the μP detects the RDY signal and has read the data, it can terminate the Read Cycle by toggling the RD input pin "High".
- **6.** The  $\overline{\text{CS}}$  input pin must be pulled "High" before a new command can be issued.

# Write Cycle (For Pmode = "0" or "1")

Whenever a local µP wishes to write a byte or word of data into a register within the LIU, it should do the following.

- 1. Place the address of the target register on the address bus input pins Addr[7:0].
- 2. While the  $\underline{\mu P}$  is placing this address value on the address bus, the address decoding circuitry should assert the  $\overline{CS}$  pin of the LIU, by toggling it "Low". This action enables communication between the  $\mu P$  and the LIU microprocessor interface block.
- 3. The  $\mu P$  should then place the byte or word that it intends to write into the target register, on the bi-directional data bus D[7:0].
- **4.** Next, the  $\mu$ P should indicate that this current bus cycle is a Write operation by toggling the  $\overline{WR}$  input pin "Low". This action enables the bi-directional data bus input drivers of the LIU.
- 5. After the  $\mu P$  toggles the Write signal "Low", the LIU will toggle the  $\overline{RDY}$  output pin "Low". The LIU does this to inform the  $\mu P$  that the data has been written into the internal register location, and that it is ready for the next command.
- 6. The  $\overline{\text{CS}}$  input pin must be pulled "High" before a new command can be issued.

FIGURE 35. ASYNCHRONOUS µP INTERFACE SIGNALS DURING PROGRAMMED I/O READ AND WRITE OPERATIONS



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#### TWELVE CHANNEL E3/DS3/STS-1 LINE INTERFACE UNIT

TABLE 15: ASYNCHRONOUS TIMING SPECIFICATIONS

SYMBOL	PARAMETER	MIN	Max	Units
t <sub>0</sub>	Valid Address to CS Falling Edge	0	-	ns
t <sub>1</sub>	CS Falling Edge to RD Assert	0	-	ns
t <sub>2</sub>	RD Assert to RDY Assert	-	65	ns
NA	RD Pulse Width (t <sub>2</sub> )	70	-	ns
t <sub>3</sub>	CS Falling Edge to WR Assert	0	-	ns
t <sub>4</sub>	WR Assert to RDY Assert	•	65	ns
NA	WR Pulse Width (t <sub>4</sub> )	70	-	ns

FIGURE 36. SYNCHRONOUS µP INTERFACE SIGNALS DURING PROGRAMMED I/O READ AND WRITE OPERATIONS

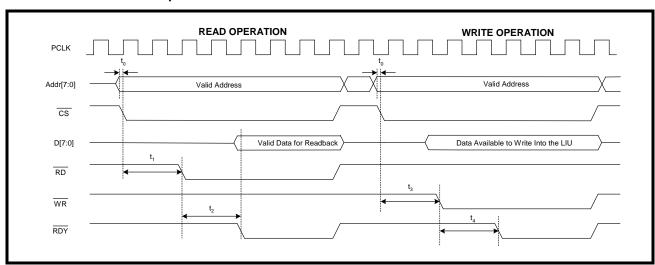


TABLE 16: SYNCHRONOUS TIMING SPECIFICATIONS

SYMBOL	PARAMETER	Min	Max	Units
$t_0$	Valid Address to CS Falling Edge	0	-	ns
t <sub>1</sub>	CS Falling Edge to RD Assert	0	-	ns
t <sub>2</sub>	RD Assert to RDY Assert	-	35	ns, see note 1
NA	RD Pulse Width (t <sub>2</sub> )	40	-	ns
t <sub>3</sub>	CS Falling Edge to WR Assert	0	-	ns
t <sub>4</sub>	WR Assert to RDY Assert	-	35	ns, see note 1
NA	WR Pulse Width (t <sub>4</sub> )	40	-	ns
	PCLK Period	15		ns
	PCLK Duty Cycle			
	PCLK "High/Low" time			

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**Note:** 1. This timing parameter is based on the frequency of the synchronous clock (PCLK). To determine the access time, use the following formula: (PCLK<sub>period</sub> \* 2) + 5ns

# 7.3 Register Map

TABLE 17: COMMAND REGISTER ADDRESS MAP, WITHIN THE XRT73R12

Address (Hex)	COMMAND REGISTER (DECIMAL)	LABEL	Түре	REGISTER NAME
0x00	CR0	APST	R/W	APS Transmit Redundancy Control Register 0-5
	Сна	NNEL 0 CO	NTROL RE	GISTERS
0x01	CR1	IER0	R/W	Source Level Interrupt Enable Register - Ch 0
0x02	CR2	ISR0	RUR	Source Level Interrupt Status Register Ch 0
0x03	CR3	AS0	R/O	Alarm Status Register - Ch 0
0x04	CR4	TC0	R/W	Transmit Control Register - Ch 0
0x05	CR5	RC0	R/W	Receive Control Register - Ch 0
0x06	CR6	CC0	R/W	Channel Control Register - Ch 0
0x07	CR7			Reserved
0x08	CR8	APSR	R/W	APS Receive Redundancy Control Register 0-5
0x09				
0x0A	CR10	EM0	R/W	Error counter MS Byte Ch 0
0x0B	CR11	EL0	R/W	Error counter LS Byte
0x0C	CR12	EH0	R/W	Error counter Holding register
0x0D				
0x0E				
0x0F				
0x10				
	Сна	NNEL 1 Co	NTROL RE	GISTERS
0x11	CR17	IER1	R/W	Source Level Interrupt Enable Register - Ch 1
0x12	CR18	ISR1	RUR	Source Level Interrupt Status Register - Ch 1
0x13	CR19	AS1	R/O	Alarm Status Register - Ch 1
0x14	CR20	TC0	R/W	Transmit Control Register - Ch 1
0x15	CR21	RC1	R/W	Receive Control Register - Ch 1
0x16	CR22	CC1	R/W	Channel Control Register - Ch 1
0x17	CR23			Reserved
0x18				
0x19				
0x1A	CR26	EM1	R/W	Error counter MSByte Ch 1

Address (Hex)	COMMAND REGISTER (DECIMAL)	LABEL	Түре	REGISTER NAME
0x1B	CR27	EL1	R/W	Error counter LSbyte
0x1C	CR28	EH1	R/W	Error counter Holding register
0x1C	CNZO	CIII	IN/VV	Error counter Floraling register
0x1D 0x1E				
0x1F				
0x20				
	1	T	NTROL RE	
0x21	CR33	IER2	R/W	Source Level Interrupt Enable Register - Ch 2
0x22	CR34	ISR2	RUR	Source Level Interrupt Status Register - Ch 2
0x23	CR35	AS2	R/O	Alarm Status Register - Ch 2
0x24	CR36	TC2	R/W	Transmit Control Register - Ch 2
0x25	CR37	RC2	R/W	Receive Control Register - Ch 2
0x26	CR38	CC2	R/W	Channel Control Register - Ch 2
0x27	CR39			Reserved
0x28				
0x29				
0x2A	CR42	EM2	R/W	Error counter MSByte Ch 2
0x2B	CR43	EL2	R/W	Error counter LSbyte
0x2C	CR44	EH2	R/W	Error counter Holding register
0x2D				
0x2E				
0x2F				
0x30				
	Сна	NNEL 3 Co	NTROL RE	GISTERS
0x31	CR49	IER3	R/W	Source Level Interrupt Enable Register - Ch 3
0x32	CR50	ISR3	RUR	Source Level Interrupt Status Register - Ch 3
0x33	CR51	AS3	R/O	Alarm Status Register - Ch 3
0x34	CR52	TC3	R/W	Transmit Control Register - Ch 3
0x35	CR53	RC3	R/W	Receive Control Register - Ch 3
0x36	CR54	CC3	R/W	Channel Control Register - Ch 3
0x37	CR55			Reserved
0x38				
0x39				



Address (Hex)	COMMAND REGISTER (DECIMAL)	LABEL	Түре	REGISTER NAME			
0x3A	CR58	ЕМ3	R/W	Error counter MSByte Ch 3			
0x3B	CR59	EL3	R/W	Error counter LSbyte			
0x3C	CR60	EH3	R/W	Error counter Holding register			
0x3D							
0x3E							
0x3F							
0x40							
	Сна	NNEL 4 Co	NTROL RE	GISTERS			
0x41	CR65	IER4	R/W	Source Level Interrupt Enable Register - Ch			
0x42	CR66	ISR4	RUR	Source Level Interrupt Status Register - Ch 4			
0x43	CR67	AS4	R/O	Alarm Status Register - Ch 4			
0x44	CR68	TC4	R/W	Transmit Control Register - Ch 4			
0x45	CR69	RC4	R/W	Receive Control Register - Ch 4			
0x46	CR70	CC4	R/W	Channel Control Register - Ch 4			
0x47	CR71			Reserved			
0x48							
0x49							
0x4A	CR74	EM4	R/W	Error counter MSByte Ch 4			
0x4B	CR75	EL4	R/W	Error counter LSbyte			
0x4C	CR76	EH4	R/W	Error counter Holding register			
0x4D							
0x4E							
0x4F							
0x50							
	Сна	NNEL 5 CO	NTROL RE	GISTERS			
0x51	CR81	IER5	R/W	Source Level Interrupt Enable Register - Ch			
0x52	CR82	ISR5	RUR	Source Level Interrupt Status Register - Ch &			
0x53	CR83	AS5	R/O	Alarm Status Register - Ch 5			
0x54	CR84	TC5	R/W	Transmit Control Register - Ch 5			
0x55	CR85	RC5	R/W	Receive Control Register - Ch 5			
0x56	CR86	CC5	R/W	Channel Control Register - Ch 5			
0x57	CR87			Reserved			

0x58

	TWEEVE OFFAITHER IS						
Address (Hex)	COMMAND REGISTER (DECIMAL)	LABEL	ТҮРЕ	REGISTER NAME			
0x59							
0x5A	CR90	EM5	R/W	Error counter MSByte Ch 5			
0x5B	CR91	EL5	R/W	Error counter LSbyte			
0x5C	CR92	EH5	R/W	Error counter Holding register			
0x5D							
0x5E							
0x5F							
0x60	CR96	CIE	R/W	Channel 0-5 Interrupt Enable flags			
0x61	CR97	CIS	R/O	Channel 0-5 Interrupt status flags			
0x62							
0x63							
0x64							
0x65							
0x66							
0x67							
0x68							
0x65							
0x69							
0x6A							
0x6B							
0x6C							
0x6D							
0x6E	CR110	PN	R/O	Device Part Number Register			
0x6F	CR111	VN	R/O	Chip Revision Number Register			
0x70							
0x71							
0x72							
0x73							
0x74							
0x75							
0x76							
0x77							
0x78							



Address (Hex)	COMMAND REGISTER (DECIMAL)	LABEL	Түре	REGISTER NAME
0x75				
0x79				
0x7A				
0x7B				
0x7C				
0x7D				
0x7E				
0x7F				
0x80	CR128	APST	R/W	APS Transmit Redundancy Control Register 6-11
	Сна	NNEL 6 CC	NTROL RE	GISTERS
0x81	CR129	IER6	R/W	Source Level Interrupt Enable Register - Ch 6
0x82	CR130	ISR6	RUR	Source Level Interrupt Status Register - Ch 6
0x83	CR131	AS6	R/O	Alarm Status Register - Ch 6
0x84	CR132	TC6	R/W	Transmit Control Register - Ch 6
0x85	CR133	RC6	R/W	Receive Control Register - Ch 6
0x86	CR134	CC6	R/W	Channel Control Register - Ch 6
0x87	CR135			Reserved
0x88	CR136	APSR	R/W	APS Receive Redundancy Control Register 6-11
0x89				
0x8A	CR138	EM6	R/W	Error counter MSByte Ch 6
0x8B	CR139	EL6	R/W	Error counter LSbyte
0x8C	CR140	EH6	R/W	Error counter Holding register
0x8D				
0x8E				
0x8F				
0x90				
	Сна	NNEL 7 Co	NTROL RE	GISTERS
0x91	CR145	IER7	R/W	Source Level Interrupt Enable Register - Ch 7
0x92	CR146	ISR7	RUR	Source Level Interrupt Status Register - Ch 7
0x93	CR147	AS7	R/O	Alarm Status Register - Ch 7
0x94	CR148	TC7	R/W	Transmit Control Register - Ch 7
0x95	CR149	RC7	R/W	Receive Control Register - Ch 7
0x96	CR150	CC7	R/W	Channel Control Register - Ch 7

Address	COMMAND REGISTER	REGISTER LABEL TYPE REGISTER NAME		
(HEX)	(DECIMAL)	LABEL	TYPE	REGISTER NAME
0x97	CR151			Reserved
0x98				
0x99				
0x9A	CR154	EM7	R/W	Error counter MSByte Ch 7
0x9B	CR155	EL7	R/W	Error counter LSbyte
0x9C	CR156	EH7	R/W	Error counter Holding register
0x9D				
0x9E				
0x9F				
0xA0				
	Сна	NNEL 8 CO	NTROL RE	GISTERS
0xA1	CR161	IER8	R/W	Source Level Interrupt Enable Register - Ch 8
0xA2	CR162	ISR8	RUR	Source Level Interrupt Status Register - Ch 8
0xA3	CR163	AS8	R/O	Alarm Status Register - Ch 8
0xA4	CR164	TC8	R/W	Transmit Control Register - Ch 8
0xA5	CR165	RC8	R/W	Receive Control Register - Ch 8
0xA6	CR166	CC8	R/W	Channel Control Register - Ch 8
0xA7	CR167			Reserved
0xA8				
0xA9				
0xAA	CR170	EM8	R/W	Error counter MSByte Ch 8
0xAB	CR171	EL8	R/W	Error counter LSbyte
0xAC	CR172	EH8	R/W	Error counter Holding register
0xAD				
0xAE				
0xAF				
0xB0				
	Сна	NNEL 9 CO	NTROL RE	GISTERS
0xB1	CR177	IER9	R/W	Source Level Interrupt Enable Register - Ch 9
0xB2	CR178	ISR9	RUR	Source Level Interrupt Status Register - Ch 9
0xB3	CR179	AS9	R/O	Alarm Status Register - Ch 9
0xB4	CR180	TC9	R/W	Transmit Control Register - Ch 9
0xB5	CR181	RC9	R/W	Receive Control Register - Ch 9



Address	COMMAND REGISTER						
(HEX)	(DECIMAL)	LABEL	TYPE	REGISTER NAME			
0xB6	CR182	CC9	R/W	Channel Control Register - Ch 9			
0xB7	CR183			Reserved			
0xB8							
0xB9							
0xBA	CR186	EM9	R/W	Error counter MSByte Ch 9			
0xBB	CR187	EL9	R/W	Error counter LSbyte			
0xBC	CR188	EH9	R/W	Error counter Holding register			
0xBD							
0xBE							
0xBF							
0xC0							
CHANNEL 10 CONTROL REGISTERS							
0xC1	CR193	IER10	R/W	Source Level Interrupt Enable Register - Ch 10			
0xC2	CR194	ISR10	RUR	Source Level Interrupt Status Register - Ch 10			
0xC3	CR195	AS10	R/O	Alarm Status Register - Ch 10			
0xC4	CR196	TC10	R/W	Transmit Control Register - Ch 10			
0xC5	CR197	RC10	R/W	Receive Control Register - Ch 10			
0xC6	CR198	CC10	R/W	Channel Control Register - Ch 10			
0xC7	CR199			Reserved			
0xC8							
0xC9							
0xCA	CR202	EM10	R/W	Error counter MSByte Ch 10			
0xCB	CR203	EL10	R/W	Error counter LSbyte			
0xCC	CR204	EH10	R/W	Error counter Holding register			
0xCD							
0xCE							
0xCF							
0xD0							
	Снаг	NNEL 11 C	ONTROL RE	GISTERS			
0xD1	CR209	IER11	R/W	Source Level Interrupt Enable Register - Ch 11			
0xD2	CR210	ISR11	RUR	Source Level Interrupt Status Register - Ch 11			
0xD3	CR211	AS11	R/O	Alarm Status Register - Ch 11			
0xD4	CR212	TC11	R/W	Transmit Control Register - Ch 11			

Address (Hex)	COMMAND REGISTER (DECIMAL)	LABEL	Түре	REGISTER NAME
0xD5	CR213	RC11	R/W	Receive Control Register - Ch 11
0xD6	CR214	CC11	R/W	Channel Control Register - Ch 11
0xD7	CR215			Reserved
0xD8				
0xD9				
0xDA	CR218	EM11	R/W	Error counter MSByte Ch 11
0xDB	CR219	EL11	R/W	Error counter LSbyte
0xDC	CR229	EH11	R/W	Error counter Holding register
0xDD				
0xDE				
0xDF				
0xE0	CR224	CIE	R/W	Channel 6-11 Interrupt enable flags
0xE1	CR225	CIS	R/O	Channel 6-11 Interrupt status flags
0xE2				
0xE3				
0xE4				
0xE5				
0xE6				
0xE7				
0xE8				
0xE5				
0xE9				
0xEA				
0xEB				
0xEC				
0xED				
0xEE				
0xEF				
0xF0				
0xF1				
0xF2				
0xF3				
0xF4				

#### XRT73R12



# **TWELVE CHANNEL E3/DS3/STS-1 LINE INTERFACE UNIT**

Address **COMMAND REGISTER** LABEL TYPE REGISTER NAME (HEX) (DECIMAL) 0xF5 0xF6 0xF7 0xF8 0xF5 0xF9 0xFA 0xFB 0xFC 0xFD 0xFE 0xFF

#### THE GLOBAL/CHIP-LEVEL REGISTERS

The register set, within the XRT73R12 contains ten global or chip-level registers. These registers control operations in more than one channel or apply to the complete chip. This section will present detailed information on the Global Registers.

TABLE 18: LIST AND ADDRESS LOCATIONS OF GLOBAL REGISTERS

Address	COMMAND REGISTER	LABEL	Түре	REGISTER NAME	
0x00	CR0	APST	R/W	APS Transmit Redundancy Control Register 0-5	
0x08	CR8	APSR	R/W	APS Receive Redundancy Control Register 0-5	
0x80	CR128	APST	R/W	APS Transmit Redundancy Control Register 6-11	
0x88	CR136	APSR	R/W	APS Receive Redundancy Control Register 6-11	
0x60	CR96	CIE	R/W	Channel 0-5 Interrupt Enable flags	
0x61	CR97	CIS	R/O	Channel 0-5 Interrupt Status flags	
0xE0	CR224	CIE	R/W	Channel 6-11 Interrupt Enable flags	
0xE1	CR225	CIS	R/O	Channel 6-11 Interrupt Status flags	
0x6E	CR110	PN	ROM	Device Part Number Register	
0x6F	CR111	VN	ROM	Chip Revision/Version Number Register	

#### **REGISTER DESCRIPTION - GLOBAL REGISTERS**

TABLE 19: APS/REDUNDANCY TRANSMIT CONTROL REGISTER - CR0 (ADDRESS LOCATION = 0x00)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Reserved	Reserved	TxON Ch 5	TxON Ch 4	TxON Ch 3	TxON Ch 2	TxON Ch 1	TxON Ch 0
		R/W	R/W	R/W	R/W	R/W	R/W

BIT NUMBER	NAME	Түре	DESCRIPTION
7,6	Reserved		
5 4 3 2 1 0	TXON Ch 5 TXON Ch 4 TXON Ch 3 TXON Ch 2 TXON Ch 1 TXON Ch 0	R/W	Transmit Section ON - Channel n  This READ/WRITE bit-field is used to turn on or turn off the Transmit Driver associated with Channel n. If the user turns on the Transmit Driver, then Channel n will transmit DS3, E3 or STS-1 pulses on the line via the TTIP_n and TRING_n output pins.  Conversely, if the user turns off the Transmit Driver, then the TTIP_n and TRING_n output pins will be tri-stated.  0 - Shuts off the Transmit Driver associated with Channel n and tri-states the TTIP_n and TRING_n output pins.  1 - Turns on the Transmit Driver associated with Channel n.  Note: The master TxON control pin(pin # P4) must be in a high state (logic 1) for this operation to turn on any channel.

# TABLE 20: APS/REDUNDANCY RECEIVE CONTROL REGISTER - CR8 (ADDRESS LOCATION = 0x08)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Reserved	Reserved	RxON Ch 5	RxON Ch 4	RxON Ch 3	RxON Ch 2	RxON Ch 1	RxON Ch 0
		R/W	R/W	R/W	R/W	R/W	R/W

BIT Number	NAME	Түре	DESCRIPTION
7,6	Reserved		
5	RxON Ch 5	R/W	Receive Section ON - Channel n
4	RxON Ch 4		This READ/WRITE bit-field is used to turn on or turn off the Receiver associated with
3	RxON Ch 3		Channel n on a per channel basis. If the user turns on the Receiver, then Channel n
2	RxON Ch 2		will Receive DS3, E3 or STS-1 pulses on the line via the RTIP_n and RRING_ n input
1	RxON Ch 1		pins.
0	RxON Ch 0		Conversely, if the user turns off the Receiver Driver (for channel n), the RTIP_n and RRING_n input pins will be in a high impedance state.
			0 - Shuts off the Receive Driver associated with Channel n and puts the RTIP_n and RRING_ n input pins in a high impedance state.  1 - Turns on the Receive Driver associated with Channel n.

# TABLE 21: APS/REDUNDANCY TRANSMIT CONTROL REGISTER - CR128 (ADDRESS LOCATION = 0x80)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Reserved	Reserved	TxON Ch 11	TxON Ch 10	TxON Ch 9	TxON Ch 8	TxON Ch 7	TxON Ch 6
		R/W	R/W	R/W	R/W	R/W	R/W

BIT Number	NAME	Түре	DESCRIPTION
7,6	Reserved		
5	TxON Ch 11	R/W	Transmit Section ON - Channel n
4	TxON Ch 10		This READ/WRITE bit-field is used to turn on or turn off the Transmit Driver associated
3	TxON Ch 9		with Channel n. If the user turns on the Transmit Driver, then Channel n will transmit
2	TxON Ch 8		DS3, E3 or STS-1 pulses on the line via the TTIP_n and TRING_ n output pins.
1	TxON Ch 7		Conversely, if the user turns off the Transmit Driver, then the TTIP_n and TRING_n
0	TxON Ch 6		output pins will be tri-stated.
			0 - Shuts off the Transmit Driver associated with Channel n and tri-states the TTIP_n and TRING_ n output pins.
			1 - Turns on the Transmit Driver associated with Channel n.
			<b>Note:</b> The master TxON control pin(pin # P4) <b>must</b> be in a high state (logic 1) for this operation to turn on any channel.

# TABLE 22: APS/REDUNDANCY RECEIVE CONTROL REGISTER - CR136 (ADDRESS LOCATION = 0x88)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Reserved	Reserved	RxON Ch 11	RxON Ch 10	RxON Ch 9	RxON Ch 8	RxON Ch 7	RxON Ch 6
		R/W	R/W	R/W	R/W	R/W	R/W

BIT Number	NAME	Түре	DESCRIPTION
7,6	Reserved		
5	RxON Ch 11	R/W	Receive Section ON - Channel n
4	RxON Ch 10		This READ/WRITE bit-field is used to turn on or turn off the Receiver associated with
3	RxON Ch 9		Channel n on a per channel basis. If the user turns on the Receiver, then Channel n will Receive DS3, E3 or STS-1 pulses on the line via the RTIP n and RRING n input
2	RxON Ch 8		pins.
1	RxON Ch 7		Conversely, if the user turns off the Receiver Driver (for channel n), the RTIP n and
0	RxON Ch 6		RRING_n input pins will be in a high impedance state.
			Shuts off the Receive Driver associated with Channel n and puts the RTIP_n and RRING_ n input pins in a high impedance state.      Turns on the Receive Driver associated with Channel n.

# FIGURE 37. CHANNEL LEVEL INTERRUPT ENABLE REGISTER - CR96 (ADDRESS LOCATION = 0x60)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Reserved	Reserved	Channel 5 Interrupt Enable	Channel 4 Interrupt Enable	Channel 3 Interrupt Enable	Channel 2 Interrupt Enable	Channel 1 Interrupt Enable	Channel 0 Interrupt Enable
		R/W	R/W	R/W	R/W	R/W	R/W

BIT NUMBER	NAME	Түре	DESCRIPTION
7,6	Unused		
5	Channel 5 Interrupt Enable	R/W	Channel n Interrupt Enable Bit:
4	Channel 4 Interrupt Enable		This READ/WRITE bit is used to:
3 2	Channel 3 Interrupt Enable Channel 2 Interrupt Enable		To enable Channel n for Interrupt Generation at the Channel Level
1 0	Channel 1 Interrupt Enable Channel 0 Interrupt Enable		To disable all Interrupts associated with Channel n within the XRT73R12
			This is a "master" enable bit for <i>each</i> channel. This bit allows control on a per channel basis to signal the Host of selected error conditions.
			If a bit is cleared, no interrupts from that channel will be sent to the Host via the INT.
			If the bit is set (logic 1), any generated interrupt in channel n that has been enabled in the Interrupt Enable register (IERn) for the channel will activate the INT pin to the Host.
			O - Disables all Channel n related Interrupts.     1 - Enables Channel n-related Interrupts. The user <b>must enable</b> individual Channel n related Interrupts at the source level, before they are can generate an interrupt.

# TABLE 23: CHANNEL LEVEL INTERRUPT ENABLE REGISTER - CR224 (ADDRESS LOCATION = 0xE0

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Reserved	Reserved	Channel 11 Interrupt Enable	Channel 10 Interrupt Enable	Channel 9 Interrupt Enable	Channel 8 Interrupt Enable	Channel 7 Interrupt Enable	Channel 6 Interrupt Enable
		R/W	R/W	R/W	R/W	R/W	R/W

BIT Number	Name	Түре	DESCRIPTION
7,6	Reserved		
5 4 3 2 1 0	Channel 11 Interrupt Enable Channel 10 Interrupt Enable Channel 9 Interrupt Enable Channel 8 Interrupt Enable Channel 7 Interrupt Enable Channel 6 Interrupt Enable	R/W	Channel n Interrupt Enable Bit: This READ/WRITE bit is used to:  To enable Channel n for Interrupt Generation at the Channel Level  To disable all Interrupts associated with Channel n within the XRT73R12  This is a "master" enable bit for each channel. This bit allows control on a per channel basis to signal the Host of selected error conditions.  If a bit is cleared, no interrupts from that channel will be sent to the Host via the INT pin.  If the bit is set (logic 1), any generated interrupt in channel n that has been enabled in the Interrupt Enable register (IERn) for the channel will activate the INT pin to the Host.  D - Disables all Channel n related Interrupts.  The user must enable individual Channel n related Interrupts at the source level, before

Table 24: Channel Level Interrupt Status Register - CR97 (Address Location = 0x61)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Reserved	Reserved	Channel 5 Interrupt Status	Channel 4 Interrupt Status	Channel 3 Interrupt Status	Channel 2 Interrupt Status	Channel 1 Interrupt Status	Channel 0 Interrupt Status
		R/O	R/O	R/O	R/O	R/O	R/O

BIT Number	Name	Түре	DESCRIPTION			
7, 6	Reserved					
5 4 3 2 1 0	Channel 5 Interrupt Status Channel 4 Interrupt Status Channel 3 Interrupt Status Channel 2 Interrupt Status Channel 1 Interrupt Status Channel 0 Interrupt Status	R/O	Channel n Interrupt Status Bit: This READ-ONLY bit-field indicates whether the XRT73R12 has a pending Channel n-related interrupt that is awaiting service. The first six channels are serviced through this location and the other six at address 0xE1. These two registers are used by the Host to identify the source channel of an active interrupt.  0 - Indicates that there is NO Channel n-related Interrupt awaiting service.  1 - Indicates that there is at least one Channel n-related Interrupt awaiting			
			service. In this case, the user's Interrupt Service routine should be written such that the Microprocessor will now proceed to read out the contents of the Source Level Interrupt Status Register - Channel n (Address Locations = 0xn2) to determine the exact source of the interrupt request.  Note: Once this bit-field is set to "1", it will not be cleared back to "0" until the user has read out the contents of the Source-Level Interrupt Status Register bit, that corresponds to the interrupt request channel.			

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#### TABLE 25: CHANNEL LEVEL INTERRUPT STATUS REGISTER - CR225 (ADDRESS LOCATION = 0xE1)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Reserved	Reserved	Channel 11 Interrupt Status	Channel 10 Interrupt Status	Channel 9 Interrupt Status	Channel 8 Interrupt Status	Channel 7 Interrupt Status	Channel 6 Interrupt Status
		R/O	R/O	R/O	R/O	R/O	R/O

BIT Number	Name	Түре	DESCRIPTION
7, 6	Reserved		
5 4 3 2 1 0	Channel 11 Interrupt Status Channel 10 Interrupt Status Channel 9 Interrupt Status Channel 8 Interrupt Status Channel 7 Interrupt Status Channel 6 Interrupt Status	R/O	Channel n Interrupt Status Bit:  This READ-ONLY bit-field indicates whether the XRT73R12 has a pending Channel n-related interrupt that is awaiting service. The last six channels are serviced through this location and the other six at address 0x61. These two registers are used by the Host to identify the source channel of an active interrupt.  0 - Indicates that there is NO Channel n-related Interrupt awaiting service.  1 - Indicates that there is at least one Channel n-related Interrupt awaiting service. In this case, the user's Interrupt Service routine should be written such that the Microprocessor will now proceed to read out the contents of the Source Level Interrupt Status Register - Channel n (Address Locations = 0xn2) to determine the exact source of the interrupt request.  Note: Once this bit-field is set to "1", it will not be cleared back to "0" until the user has read out the contents of the Source-Level Interrupt Status Register bit, that corresponds to the interrupt request channel.

# TABLE 26: DEVICE/PART NUMBER REGISTER - CR110 (ADDRESS LOCATION = 0x6E)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0				
	Part Number ID Value										
R/O	R/O	R/O	R/O	R/O	R/O	R/O	R/O				
0	1	1	0	1	0	0	0				

BIT NUMBER	Name	Түре	DEFAULT VALUE	DESCRIPTION
7 - 0	Part Number ID Value	R/O		Part Number ID Value: This READ-ONLY register contains a unique value for the XRT73R12. This value will always be 0x68.



TABLE 27: CHIP REVISION NUMBER REGISTER - CR111 (ADDRESS LOCATION = 0x6F)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0		
	Chip Revision Number Value								
R/O	R/O	R/O	R/O	R/O	R/O	R/O	R/O		
0	0	0	0	Х	Х	Х	Х		

BIT NUMBER	NAME	Түре	DEFAULT VALUE	DESCRIPTION
7 - 0	Chip Revision Number Value	R/O	0x0#	Chip Revision Number Value: This READ-ONLY register contains a value that represents the current revision of this XRT73R12. This revision number will always be in the form of "0x0#", where "#" is a hexadecimal value that specifies the current revision of the chip. For example, the very first revision of this chip will contain the value "0x01".

#### THE PER-CHANNEL REGISTERS

The XRT73R12 consists of 120 per-Channel Registers (12 channels and 10 registers per channel). Table 9 presents the overall Register Map with the Per-Channel Registers unshaded.

#### **REGISTER DESCRIPTION - PER CHANNEL REGISTERS**

TABLE 28: XRT73R12 REGISTER MAP SHOWING INTERRUPT ENABLE REGISTERS (IER\_N) (N = [0:11])

Address Location	0	1	2	3	4	5	6	7	8	9	Α	В	С	D	E	F
0x0-	APST	IER0	ISR0	AS0	TC0	RC0	CC0		APSR		EM0	EL0	EH0			
0x1-		IER1	ISR1	AS1	TC1	RC1	CC1				EM1	EL1	EH1			
0x2-		IER2	ISR2	AS2	TC2	RC2	CC2				EM2	EL2	EH2			
0x3-		IER3	ISR3	AS3	TC3	RC3	CC3				ЕМ3	EL3	EH3			
0x4-		IER4	ISR4	AS4	TC4	RC4	CC4				EM4	EL4	EH4			
0x5-		IER5	ISR5	AS5	TC5	RC5	CC5				EM5	EL5	EH5			
0x6-	CIE	CIS													PN	VN
0x7-																
0x8-	APST	IER6	ISR6	AS6	TC6	RC6	CC6		APSR		EM6	EL6	EH6			
0x9-		IER7	ISR7	AS7	TC7	RC7	CC7				EM7	EL7	EH7			
0xA-		IER8	ISR8	AS8	TC8	RC8	CC8				EM8	EL8	EH8			
0xB-		IER9	ISR9	AS9	TC9	RC9	CC9				EM9	EL9	EH9			
0xC-		IER10	ISR10	AS10	TC10	RC10	CC10				EM10	EL10	EH10			
0xD-		IER11	ISR11	AS11	TC11	RC11	CC11				EM11	EL11	EH11			
0xE-	CIE	CIS														
0xF-																

# Table 29: Source Level Interrupt Enable Register - Channel N Address Location = 0xm1 (N = [0:11] & M= 0-5 & 8-D)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
		Reserved	l		Change of LOL Condition	Change of LOS Condition	Change of DMO Condition
					Interrupt Enable Ch n	Interrupt Enable Ch n	Interrupt Enable Ch n
					R/W	R/W	R/W

BIT NUMBER	NAME	Түре	DESCRIPTION
7 - 3	Reserved	R/O	
2	Change of LOL Condition Interrupt Enable	R/W	Change of Receive LOL (Loss of Lock) Condition Interrupt Enable - Channel n:  This READ/WRITE bit-field is used to enable or disable the Change of Receive LOL Condition Interrupt. If the user enables this interrupt, then the XRT73R12 will generate an interrupt any time any of the following events occur.  • Whenever the Receive Section (within Channel n) declares the Loss of Lock Condition.  • Whenever the Receive Section (within Channel n) clears the Loss of Lock Condition.  • Disables the Change in Receive LOL Condition Interrupt.  1 - Enables the Change in Receive LOL Condition Interrupt.
1	Change of LOS Condition Interrupt Enable	R/W	Change of the Receive LOS (Loss of Signal) Defect Condition Interrupt Enable - Ch 0:  This READ/WRITE bit-field is used to enable or disable the Change of the Receive LOS Defect Condition Interrupt. If the user enables this interrupt, then the XRT73R12 will generate an interrupt any time any of the following events occur.  • Whenever the Receive Section (within Channel n) declares the LOS Defect Condition.  • Whenever the Receive Section (within Channel n) clears the LOS Defect condition.  0 - Disables the Change in the LOS Defect Condition Interrupt.  1 - Enables the Change in the LOS Defect Condition Interrupt.
0	Change of DMO Condition Interrupt Enable	R/W	Change of Transmit DMO (Drive Monitor Output) Condition Interrupt Enable - Ch n:  This READ/WRITE bit-field is used to enable or disable the Change of Transmit DMO Condition Interrupt. If the user enables this interrupt, then the XRT73R12 will generate an interrupt any time any of the following events occur.  • Whenever the Transmit Section toggles the DMO output pin (or bit-field) to "1".  • Whenever the Transmit Section toggles the DMO output pin (or bit-field) to "0".  0 - Disables the Change in the DMO Condition Interrupt.  1 - Enables the Change in the DMO Condition Interrupt.

### TABLE 30: XRT73R12 REGISTER MAP SHOWING INTERRUPT STATUS REGISTERS (ISR\_N)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
		Reserved	t	Change of LOL	Change of LOS	Change of DMO	
					Condition	Condition	Condition
					Interrupt Status	nterrupt Status	Interrupt Status
					Ch_n	Ch_n	Ch_n
					RUR	RUR	RUR

Table 31: Source Level Interrupt Status Register - Channel n Address Location = 0xm2 (n = [0:11] & m= 0-5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
7 - 4	Reserved		
3	Change of FL Condition Interrupt Status		This bit is reserved.
2	Change of LOL Condition Interrupt Status	RUR	Change of Receive LOL (Loss of Lock) Condition Interrupt Status - Ch n:  This RESET-upon-READ bit-field indicates whether or not the Change of Receive LOL Condition Interrupt (for Channel n) has occurred since the last read of this register.  0 - Indicates that the Change of Receive LOL Condition Interrupt has NOT occurred since the last read of this register.  1 - Indicates that the Change of Receive LOL Condition Interrupt has occurred since the last read of this register.  Note: The user can determine the current state of the Receive LOL Defect condition by reading out the contents of Bit 2 (Receive LOL Defect Declared) within the Alarm Status Register.(n)



# Table 31: Source Level Interrupt Status Register - Channel n Address Location = 0xm2 (n = [0:11] & m= 0-5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
1	Change of LOS Condition Interrupt	RUR	Change of Receive LOS (Loss of Signal) Defect Condition Interrupt Status:
	Status		This RESET-upon-READ bit-field indicates whether or not the Change of the Receive LOS Defect Condition Interrupt (for Channel n) has occurred since the last read of this register.
			0 - Indicates that the Change of the Receive LOS Defect Condition Interrupt has NOT occurred since the last read of this register.
			1 - Indicates that the Change of the Receive LOS Defect Condition Interrupt has occurred since the last read of this register.
			Note: The user can determine the current state of the Receive LOS Defect condition by reading out the contents of Bit 1 (Receive LOS Defect Declared) within the Alarm Status Register.(n)
0	Change of DMO Condition Interrupt	RUR	Change of Transmit DMO (Drive Monitor Output) Condition Interrupt Status - Ch n:
	Status		This RESET-upon-READ bit-field indicates whether or not the Change of the Transmit DMO Condition Interrupt (for Channel n) has occurred since the last read of this register.
			0 - Indicates that the Change of the Transmit DMO Condition Interrupt has NOT occurred since the last read of this register.
			1 - Indicates that the Change of the Transmit DMO Condition Interrupt has occurred since the last read of this register.
			NOTE: The user can determine the current state of the Transmit DMO Condition by reading out the contents of Bit 0 (Transmit DMO Condition) within the Alarm Status Register.(n)



## TABLE 32: XRT73R12 REGISTER MAP SHOWING ALARM STATUS REGISTERS (AS\_N)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Reserved	Loss of PRBS Pattern Sync	Digital LOS Defect Declared	Analog LOS Defect Declared	Reserved	Receive LOL Defect Declared	Receive LOS Defect Declared	Transmit DMO Condition
	R/O	R/O	R/O	R/O	R/O	R/O	R/O

Table 33: Alarm Status Register - Channel N Address Location = 0xm3 (N = [0:11] & M= 0.5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
7	Reserved		
6	Loss of PRBS Pat-	R/O	Loss of PRBS Pattern Lock Indicator:
	tern Lock		This READ-ONLY bit-field indicates whether or not the PRBS Receiver (within the Receive Section of Channel n) is declaring PRBS Lock within the incoming PRBS pattern.
			If the PRBS Receiver detects a very large number of bit-errors within its incoming data-stream, then it will declare the Loss of PRBS Lock Condition.
			Conversely, if the PRBS Receiver were to detect its pre-determined PRBS pattern with the incoming DS3, E3 or STS-1 data-stream, (with little or no bit errors) then the PRBS Receiver will clear the Loss of PRBS Lock condition.
			0 - Indicates that the PRBS Receiver is currently declaring the PRBS Lock condition within the incoming DS3, E3 or STS-1 data-stream.
			1 - Indicates that the PRBS Receiver is currently declaring the Loss of PRBS Lock condition within the incoming DS3, E3 or STs-1 data-stream.
			NOTE: This register bit is only valid if all of the following are true.
			a. The PRBS Generator block (within the Transmit Section of the Chip is enabled).
			<b>b.</b> The PRBS Receiver is enabled.
			c. The PRBS Pattern (that is generated by the PRBS Generator) is somehow looped back into the Receive Path (via the Line-Side) and in-turn routed to the receive input of the PRBS Receiver.



Table 33: Alarm Status Register - Channel N Address Location = 0xm3 (N = [0:11] & M= 0-5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
5	Digital LOS Defect Declared	R/O	Digital LOS Defect Declared: This READ-ONLY bit-field indicates whether or not the Digital LOS (Loss of Signal) detector is declaring the LOS Defect condition. For DS3 and STS-1 applications, the Digital LOS Detector will declare the LOS Defect condition whenever it detects an absence of pulses (within the incoming DS3 or STS-1 data-stream) for 160 consecutive bit-periods. Further, (again for DS3 and STS-1 applications) the Digital LOS Detector will clear the LOS Defect condition whenever it determines that the pulse density (within the incoming DS3 or STS-1 signal) is at least 33%.  0 - Indicates that the Digital LOS Detector is NOT declaring the LOS Defect Condition.  1 - Indicates that the Digital LOS Detector is currently declaring the LOS Defect condition.  Notes:  1. LOS Detection (within each channel of the XRT73R12) is performed by both an Analog LOS Detector and a Digital LOS Detector. The LOS state of a given Channel is simply a WIRED-OR of the LOS Defect Declare states of these two detectors.  2. The current LOS Defect Condition (for the channel) can be determined by reading out the contents of Bit 1 (Receive LOS Defect Declared) within this register.
4	Analog LOS Defect Declared	R/O	Analog LOS Defect Declared:  This READ-ONLY bit-field indicates whether or not the Analog LOS (Loss of Signal) detector is declaring the LOS Defect condition.  For DS3 and STS-1 applications, the Analog LOS Detector will declare the LOS Defect condition whenever it determines that the amplitude of the pulses (within the incoming DS3/STS-1 line signal) drops below a certain Analog LOS Defect Declaration threshold level.  Conversely, (again for DS3 and STS-1 applications) the Analog LOS Detector will clear the LOS Defect condition whenever it determines that the amplitude of the pulses (within the incoming DS3/STS-1 line signal) has risen above a certain Analog LOS Defect Clearance threshold level. It should be noted that, in order to prevent "chattering" within the Analog LOS Detector output, there is some built-in hysteresis between the Analog LOS Defect Declaration and the Analog LOS Defect Clearance threshold levels.  0 - Indicates that the Analog LOS Detector is NOT declaring the LOS Defect Condition.  1 - Indicates that the Analog LOS Detector is currently declaring the LOS Defect condition.  Notes:  1. LOS Detection (within each channel of the XRT73R12) is performed by both an Analog LOS Detector and a Digital LOS Detector. The LOS state of a given Channel is simply a WIRED-OR of the LOS Defect Declare states of these two detectors.  2. The current LOS Defect Condition (for the channel) can be determined by reading out the contents of Bit 1 (Receive LOS Defect Declared) within this register.
3		<u>I</u>	Reserved

TABLE 33: ALARM STATUS REGISTER - CHANNEL N ADDRESS LOCATION = 0xm3 (N = [0:11] & M = 0.5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
2	Receive LOL Condition Declared	R/O	Receive LOL (Loss of Lock) Condition Declared: This READ-ONLY bit-field indicates whether or not the Receive Section (within Channel_n) is currently declaring the LOL (Loss of Lock) condition. The Receive Section (of Channel_n) will declare the LOL Condition, if the frequency of the Recovered Clock signal differs from that of the reference clock programmed for that channel (from the appropriate oscillator or the SFM clock synthesizer if in that mode) by 0.5% (or 5000ppm) or more .  0 - Indicates that the Receive Section of Channel_n is NOT currently declaring the LOL Condition.  1 - Indicates that the Receive Section of Channel_n is currently declaring the LOL Condition and the recovered clock differs by more than 0.5%
1	Receive LOS Defect Condition Declared	R/O	Receive LOS (Loss of Signal) Defect Condition Declared: This READ-ONLY bit-field indicates whether or not the Receive Section (within Channel_n) is currently declaring the LOS defect condition. The Receive Section (of Channel_n) will declare the LOS defect condition, if any one of the following conditions is met.  • If the Digital LOS Detector declares the LOS defect condition (for DS3 or STS-1 applications)  • If the Analog LOS Detector declares the LOS defect condition (for DS3 or STS-1 applications)  • If the ITU-T G.775 LOS Detector declares the LOS defect condition (for E3 applications).  0 - Indicates that the Receive Section of Channel_n is NOT currently declaring the LOS Defect Condition.  1 - Indicates that the Receive Section of Channel_n is currently declaring the LOS Defect condition.
0	Transmit DMO Condition Declared	R/O	Transmit DMO (Drive Monitor Output) Condition Declared: This READ-ONLY bit-field indicates whether or not the Transmit Section of Channel_n is currently declaring the DMO Alarm condition. As configured, the Transmit Section will either internally (via the TTIP_n and TRING_n) or externally (via the MTIP_n and MRING_n) check the Transmit Output DS3/E3/STS-1 Line signal for bipolar pulses. If the Transmit Section were to detect no bipolar for 128 consecutive bit-periods, then it will declare the Transmit DMO Alarm condition. This particular alarm can be used to check for fault conditions on the Transmit Output Line Signal path. The Transmit Section will clear the Transmit DMO Alarm condition upon detecting bipolar activity on the Transmit Output Line signal.  0 - Indicates that the Transmit Section of Channel_n is NOT currently declaring the Transmit DMO Alarm condition.  1 - Indicates that the Transmit Section of Channel_n is currently declaring the Transmit DMO Alarm condition.

## TABLE 34: XRT73R12Register MAP showing Transmit Control Registers (TC\_n)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Rese	erved	Internal Transmit Drive Monitor	Insert PRBS Error	Reserved	TAOS	TxCLKINV	TxLEV
		R/W	R/W		R/W	R/W	R/W

Table 35: Transmit Control Register - Channel N Address Location = 0xm4 (N = [0:11] & M= 0-5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
7 - 6	Reserved		
5	Internal Transmit Drive Monitor Enable	R/W	Internal Transmit Drive Monitor Enable - Channel_n: This READ/WRITE bit-field is used to configure the Transmit Section of Channel_n to either internally or externally monitor the TTIP_n and TRING_n output pins for bipolar pulses, in order to determine whether to declare the Transmit DMO Alarm condition.  If the user configures the Transmit Section to externally monitor the TTIP_n and TRING_n output pins (for bipolar pulses) then the user must connect the MTIP_n and MRING_n input pins to their corresponding TTIP_n and TRING_n output pins (via a 270 ohm series resistor).  If the user configures the Transmit Section to internally monitor the TTIP_n and TRING_n output pins (for bipolar pulses), the user does NOT need to conect the MTIP_n and MRING_n input pins. This monitoring will be performed internally at the TTIP_n and TRING_n pads.  0 - Configures the Transmit Drive Monitor to externally monitor the TTIP_n and TRING_n output pins for bipolar pulses.  1 - Configures the Transmit Drive Monitor to internally monitor the TTIP_n and TRING_n output pins for bipolar pulses.
4	Insert PRBS Error	R/W	Insert PRBS Error - Channel_n:  A "0 to 1" transition within this bit-field causes the PRBS Generator (within the Transmit Section of Channel_n) to generate a single bit error within the outbound PRBS pattern-stream.  Notes:  1. This bit-field is only active if the PRBS Generator and Receiver have been enabled within the corresponding Channel.  2. After writing the "1" into this register, the user must execute a write operation to clear this particular register bit to "0" in order to facilitate the next "0 to 1" transition in this bit-field.
3	Reserved		

TABLE 35: TRANSMIT CONTROL REGISTER - CHANNEL N ADDRESS LOCATION = 0xm4 (N = [0:11] & M = 0.5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
2	TAOS	R/W	Transmit All OneS Pattern - Channel_n: This READ/WRITE bit-field is used to command the Transmit Section of Channel_n to generate and transmit an unframed, All Ones pattern via the DS3, E3 or STS-1 line signal (to the remote terminal equipment). Whenever the user implements this configuration setting, the Transmit Section will ignore the data that it is accepting from the System-side equipment and output the "All Ones" Pattern.  0 - Configures the Transmit Section to transmit the data that it accepts from the System-side Interface.  1 - Configures the Transmit Section to generate and transmit the Unframed, All Ones pattern.
1	TxCLKINV	R/W	Transmit Clock Invert Select - Channel_n: This READ/WRITE bit-field is used to select the edge of the TxCLK_n input that the Transmit Section of Channel_n will use to sample the TxPOS_n and TxNEG_n input pins, as described below.  0 - Configures the Transmit Section (within the corresponding channel) to sample the TxPOS_n and TxNEG_n input pins upon the falling edge of TxCLK_n.  1 - Configures the Transmit Section (within the corresponding channel) to sample the TxPOS_n and TxNEG_n input pins upon the rising edge of TxCLK_n.  Note: This is done on a per-channel basis.
0	TxLEV	R/W	Transmit Line Build-Out Select - Channel_n: This READ/WRITE bit-field is used to enable or disable the Transmit Line Build-Out (e.g., pulse-shaping) circuit within the corresponding channel. The user should set this bit-field to either "0" or to "1" based upon the following guidelines.  0 - If the cable length between the Transmit Output (of the corresponding Channel) and the DSX-3/STSX-1 location is 225 feet or less.  1 - If the cable length between the Transmit Output (of the corresponding Channel) and the DSX-3/STSX-1 location is more than 225 feet .  The user must follow these guidelines in order to insure that the Transmit Section (of Channel_n) will always generate a DS3 pulse that complies with the Isolated Pulse Template requirements per Bellcore GR-499-CORE, or an STS-1 pulse that complies with the Pulse Template requirements per Telcordia GR-253-CORE.  Note: This bit-field is ignored if the channel has been configured to operate in the E3 Mode.

## TABLE 36: XRT73R12REGISTER MAP SHOWING RECEIVE CONTROL REGISTERS (RC\_N)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Rese	erved	Disable DLOS Detector	Disable ALOS Detector	RxCLKINV	LOSMUT Enable	Receive Monitor Mode Enable	Receive Equalizer Enable
		R/W	R/W	R/W	R/W	R/W	R/W

# Table 37: Receive Control Register - Channel N Address Location = 0xm5 (N = [0:11] & M= 0-5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
7 - 6	Reserved		
5	Disable DLOS Detector	R/W	Disable Digital LOS Detector - Channel_n: This READ/WRITE bit-field is used to enable or disable the Digital LOS (Loss of Signal) Detector within Channel_n, as described below.  0 - Enables the Digital LOS Detector within Channel_n.  1 - Disables the Digital LOS Detector within Channel_n.  Note: This bit-field is only active if Channel_n has been configured to operate in the DS3 or STS-1 Modes.
4	Disable ALOS Detector	R/W	Disable Analog LOS Detector - Channel_n: This READ/WRITE bit-field is used to either enable or disable the Analog LOS (Loss of Signal) Detector within Channel_n, as described below.  0 - Enables the Analog LOS Detector within Channel_n.  1 - Disables the Analog LOS Detector within Channel_n.  Note: This bit-field is only active if Channel_n has been configured to operate in the DS3 or STS-1 Modes.
3	RxCLKINV	R/W	Receive Clock Invert Select - Channel_n: This READ/WRITE bit-field is used to select the edge of the RxCLK_n output that the Receive Section of Channel_n will use to output the recovered data via the RxPOS_n and RxNEG_n output pins, as described below.  0 - Configures the Receive Section (within the corresponding channel) to output the recovered data via the RxPOS_n and RxNEG_n output pins upon the rising edge of RCLK_n.  1 - Configures the Receive Section (within the corresponding channel) to output the recovered data via the RxPOS_n and RxNEG_n output pins upon the falling edge of RCLK_n.

TABLE 37: RECEIVE CONTROL REGISTER - CHANNEL N ADDRESS LOCATION = 0xm5 (N = [0:11] & M = 0.5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
2	LOSMUT Enable	R/W	Muting upon LOS Enable - Channel_n: This READ/WRITE bit-field is used to configure the Receive Section (within Channel_n) to automatically pull their corresponding Recovered Data Output pins (e.g., RxPOS_n and RxNEG_n) to GND for the duration that the Receive Section declares the LOS defect condition. In other words, this feature (if enabled) will cause the Receive Channel to automatically mute the Recovered data anytime the Receive Section declares the LOS defect condition.  0 - Disables the Muting upon LOS feature. In this setting the Receive Section will NOT automatically mute the Recovered Data whenever it is declaring the LOS defect condition.  1 - Enables the Muting upon LOS feature. In this setting the Receive Section will automatically mute the Recovered Data whenever it is declaring the LOS defect condition.
1	Receive Monitor Mode Enable	R/W	Receive Monitor Mode Enable - Channel_n: This READ/WRITE bit-field is used to configure the Receive Section of Channel_n to operate in the Receive Monitor Mode. If the user configures the Receive Section to operate in the Receive Monitor Mode, then it will be able to receive a nominal DSX-3/STSX-1 signal that has been attenuator by 20dB of flat loss along with 6dB of cable loss, in an error-free manner. However, internal LOS circuitry is suppressed and LOS will never assert nor LOS be declared when operating under this mode.  0 - Configures the corresponding channel to operate in the Normal Mode. 1 - Configure the corresponding channel to operate in the Receive Monitor Mode.
0	Receive Equalizer Enable	R/W	Receive Equalizer Enable - Channel_n: This READ/WRITE register bit is used to enable or disable the Receive Equalizer block within the Receive Section of Channel_n, as listed below. 0 - Disables the Receive Equalizer within the corresponding channel. 1 - Enables the Receive Equalizer within the corresponding channel.  Note: For virtually all applications, we recommend that the user set this bit-field to "1" (for all channels) and enable the Receive Equalizer.

## TABLE 38: XRT73R12 REGISTER MAP SHOWING CHANNEL CONTROL REGISTERS (CC\_N)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Rese	erved	PRBS Enable Ch_n	RLB_n	LLB_n	E3_n	STS-1/DS3_n	SR/DR_n
		R/W	R/W	R/W	R/W	R/W	R/W

Table 39: Channel Control Register - Channel N Address Location = 0xm6 (N = [0:11] & M= 0-5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
7 - 6	Reserved		
5	PRBS Enable	R/W	PRBS Generator and Receiver Enable - Channel_n: This READ/WRITE bit-field is used to enable or disable the PRBS Generator and Receiver within a given Channel of the XRT73R12.  If the user enables the PRBS Generator and Receiver, then the following will happen.  1. The PRBS Generator (which resides within the Transmit Section of the Channel) will begin to generate an unframed, 2^15-1 PRBS Pattern (for DS3 and STS-1 applications) and an unframed, 2^23-1 PRBS Pattern (for E3 applications).  2. The PRBS Receiver (which resides within the Receive Section of the
			Channel) will now be enabled and will begin to search the incoming data for the above-mentioned PRBS patterns.  0 - Disables both the PRBS Generator and PRBS Receiver within the corresponding channel.  1 - Enables both the PRBS Generator and PRBS Receiver within the corresponding channel.  Notes:
			<ol> <li>To check and monitor PRBS Bit Errors, DR (Dual Rail) mode will be over-ridden and Single Rail mode forced for the duration of this mode. This will configure the RNEG/LCV_n output pin to function as a PRBS Error Indicator. All errors will be flagged on this pin. The errors will also be accumulated in the 16 bit Error counter for the channel.</li> </ol>
			<ol> <li>If the user enables the PRBS Generator and PRBS Receiver, the Channel will ignore the data that is being accepted from the System-side Equipment (via the TxPOS_n and TxNEG_n input pins) and will overwrite this outbound data with the PRBS Pattern.</li> <li>The system must provide an accurate and stable data-rate clock to</li> </ol>
			the TxClk_n pin during this operation.

# TABLE 39: CHANNEL CONTROL REGISTER - CHANNEL N ADDRESS LOCATION = 0xm6 (N = [0:11] & M = 0.5 & 8-D)

BIT NUMBER	Name	Түре				DESCRIPTION						
4	RLB_n	R/W		/RITE gure a	bit-field alor given chanr	Channel_n:  ng with the corresponding LLB_n bit-fi nel into various loop-back modes ass						
			LLB_n RLB_n Loop-back Mode									
			0 0 Normal (No Loop-back) Mode									
			0 1 Remote Loop-back Mode									
			1 0 Analog Local Loop-back Mode									
				1	1	Digital Local Loop-back Mode						
3	LLB_n	R/W	Loop-Back S See the table			eld - Channel_n: n.						
2	E3_n	R/W	ister, is used to Modes. 0 - Configures depending up	/RITE to con s Char oon the	bit-field, alo figure a give nnel_n to op state of Bit	ong with Bit 1 (STS-1/\overline{DS3}_n) within the channel into either the DS3, E3 or serate in either the DS3 or STS-1 Mode: 1 (STS-1/\overline{DS3}_n) within this same reerate in the E3 Mode.	STS-1					

# Table 39: Channel Control Register - Channel N Address Location = 0xm6 (N = [0:11] & M= 0-5 & 8-D)

BIT NUMBER	NAME	Түре	DESCRIPTION
1	STS-1/DS3_n	R/W	STS-1/DS3 Mode Select - Channel_n: This READ/WRITE bit-field, along with Bit 2 (E3_n) is used to configure a given channel into either the DS3, E3 or STS-1 Modes. This bit-field is ignored if Bit 2 (E3_n) has been set to "1". If Bit 2 (E3_n) is a 0: 0 - Configures Channel_n to operate in the DS3 Mode. 1 - Configures Channel_n to operate in the STS-1 Mode.
0	SR/DR_n	R/W	Single-Rail/Dual-Rail Select - Channel_n: This READ/WRITE bit-field is used to configure Channel_n to operate in either the Single-Rail or Dual-Rail Mode.  If the user configures the Channel to operate in the Single-Rail Mode, the following will happen.  • The B3ZS/HDB3 Encoder and Decoder blocks (within Channel_n) will be enabled.  • The Transmit Section of Channel_n will accept all of the outbound data (from the System-side Equipment) via the TxPOS_n input pin.  • The Receive Section of each channel will output all of the recovered data (to the System-side Equipment) via the RxPOS_n output pin.  • The corresponding RNEG/LCV_n output pin will now function as the LCV (Line Code Violation or Excessive Zero Event) indicator output pin for Channel_n.  If the user configures Channel_n to operate in the Dual-Rail Mode, the following will happen.  • The B3ZS/HDB3 Encoder and Decoder blocks of Channel_n will be disabled.  • The Transmit Section of Channel_n will be configured to accept positive-polarity data via the TxPOS_n input pin and negative-polarity data via the TxNEG_n input pin.  • The Receive Section of Channel_n will pulse the RxPOS_n output pin "High" (for one period of RCLK_n) for each time a positive-polarity pulse is received via the RTIP_n/RRING_n input pins. Likewise, the Receive Section of each channel will pulse the RxNEG_n output pin "High" (for one period of RxCLK_n) for each time a negative-polarity pulse is received via the RTIP_n/RRING_n input pins.  0 - Configures Channel_n to operate in the Dual-Rail Mode.  1 - Configures Channel_n to operate in the Single-Rail Mode.



TABLE 40: XRT73R12 REGISTER MAP SHOWING ERROR COUNTER MSBYTE REGISTERS (EM\_N) (N = [0:11])

ADDRESS LOCATION	0	1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F
0x0-	APST	IER0	ISR0	AS0	TC0	RC0	CC0		APSR		EM0	EL0	EH0			
0x1-		IER1	ISR1	AS1	TC1	RC1	CC1				EM1	EL1	EH1			
0x2-		IER2	ISR2	AS2	TC2	RC2	CC2				EM2	EL2	EH2			
0x3-		IER3	ISR3	AS3	TC3	RC3	CC3				EM3	EL3	EH3			
0x4-		IER4	ISR4	AS4	TC4	RC4	CC4				EM4	EL4	EH4			
0x5-		IER5	ISR5	AS5	TC5	RC5	CC5				EM5	EL5	EH5			
0x6-	CIE	CIS													PN	VN
0x7-																
0x8-	APST	IER6	ISR6	AS6	TC6	RC6	CC6		APSR		EM6	EL6	EH6			
0x9-		IER7	ISR7	AS7	TC7	RC7	CC7				EM7	EL7	EH7			
0xA-		IER8	ISR8	AS8	TC8	RC8	CC8				EM8	EL8	EH8			
0xB-		IER9	ISR9	AS9	TC9	RC9	CC9				EM9	EL9	EH9			
0xC-		IER10	ISR10	AS10	TC10	RC10	CC10				EM10	EL10	EH10			
0xD-		IER11	ISR11	AS11	TC11	RC11	CC11				EM11	EL11	EH11			
0xE-	CIE	CIS														
0xF-																

TABLE 41: ERROR COUNTER MSBYTE REGISTER - CHANNEL N ADDRESS LOCATION = 0xmA (M= 0-5 & 8-D)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Msb							9th bit
R/W							

TABLE 42: XRT73R12 REGISTER MAP SHOWING ERROR COUNTER LSBYTE REGISTERS (EL\_N) (N = [0:11])

ADDRESS LOCATION	0	1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F
0x0-	APST	IER0	ISR0	AS0	TC0	RC0	CC0		APSR		EM0	EL0	EH0			
0x1-		IER1	ISR1	AS1	TC1	RC1	CC1				EM1	EL1	EH1			
0x2-		IER2	ISR2	AS2	TC2	RC2	CC2				EM2	EL2	EH2			
0x3-		IER3	ISR3	AS3	TC3	RC3	CC3				ЕМ3	EL3	EH3			
0x4-		IER4	ISR4	AS4	TC4	RC4	CC4				EM4	EL4	EH4			
0x5-		IER5	ISR5	AS5	TC5	RC5	CC5				EM5	EL5	EH5			



## TABLE 42: XRT73R12 REGISTER MAP SHOWING ERROR COUNTER LSBYTE REGISTERS (EL\_N) (N = [0:11])

ADDRESS LOCATION	0	1	2	3	4	5	6	7	8	9	Α	В	С	D	Ε	F
0x6-	CIE	CIS													PN	VN
0x7-																
0x8-	APST	IER6	ISR6	AS6	TC6	RC6	CC6		APSR		EM6	EL6	EH6			
0x9-		IER7	ISR7	AS7	TC7	RC7	CC7				EM7	EL7	EH7			
0xA-		IER8	ISR8	AS8	TC8	RC8	CC8				EM8	EL8	EH8			
0xB-		IER9	ISR9	AS9	TC9	RC9	CC9				EM9	EL9	EH9			
0xC-		IER10	ISR10	AS10	TC10	RC10	CC10				EM10	EL10	EH10			
0xD-		IER11	ISR11	AS11	TC11	RC11	CC11				EM11	EL11	EH11			
0xE-	CIE	CIS														
0xF-																

## TABLE 43: ERROR COUNTER LSBYTE REGISTER - CHANNEL N ADDRESS LOCATION = 0xmB (M= 0-5 & 8-D)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
8th bit							Ls bit
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

## TABLE 44: XRT73R12 REGISTER MAP SHOWING ERROR COUNTER HOLDING REGISTERS (EH\_N) (N = [0:11])

ADDRESS LOCATION	0	1	2	3	4	5	6	7	8	9	Α	В	С	D	Ε	F
0x0-	APST	IER0	ISR0	AS0	TC0	RC0	CC0		APSR		EM0	EL0	EH0			
0x1-		IER1	ISR1	AS1	TC1	RC1	CC1				EM1	EL1	EH1			
0x2-		IER2	ISR2	AS2	TC2	RC2	CC2				EM2	EL2	EH2			
0x3-		IER3	ISR3	AS3	TC3	RC3	CC3				EM3	EL3	EH3			
0x4-		IER4	ISR4	AS4	TC4	RC4	CC4				EM4	EL4	EH4			
0x5-		IER5	ISR5	AS5	TC5	RC5	CC5				EM5	EL5	EH5			
0x6-	CIE	CIS													PN	VN
0x7-																
0x8-	APST	IER6	ISR6	AS6	TC6	RC6	CC6		APSR		EM6	EL6	EH6			
0x9-		IER7	ISR7	AS7	TC7	RC7	CC7				EM7	EL7	EH7			
0xA-		IER8	ISR8	AS8	TC8	RC8	CC8				EM8	EL8	EH8			
0xB-		IER9	ISR9	AS9	TC9	RC9	CC9				EM9	EL9	EH9			
0xC-		IER10	ISR10	AS10	TC10	RC10	CC10				EM10	EL10	EH10			
0xD-		IER11	ISR11	AS11	TC11	RC11	CC11				EM11	EL11	EH11			

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## TABLE 44: XRT73R12 REGISTER MAP SHOWING ERROR COUNTER HOLDING REGISTERS (EH\_N) (N = [0:11])

Address Location	0	1	2	3	4	5	6	7	8	9	Α	В	С	D	E	F
0xE-	CIE	CIS														
0xF-																

TABLE 45: ERROR COUNTER HOLDING REGISTER - CHANNEL N ADDRESS LOCATION = 0xMC (M= 0-5 & 8-D)

Віт 7	Віт 6	Віт 5	Віт 4	Віт 3	Віт 2	Віт 1	Віт 0
Msb							Ls bit
R/W							

Each channel contains a dedicated 16 bit PRBS error counter. When enabled this counter will accumulate PRBS errors (as well as excess zeros and LCVs). The LS byte will "carry" a one over to the MS byte each time it rolls over from 255 to zero until the MS byte also reaches 255. When both counters reach 255, no further errors will be accumulated and "all ones" will signify an overflow condition.

The counter can be read while in the active count mode. Either register may be read "on the fly" and the other byte will be simultaneously transferred into the channel's Error Holding register. The holding register may then be read to supply the Host with a correct 16 bit count (as of the instant of reading). With this mechanism, the Host could rapidly cycle thru reading all twelve counters in order (storing the read byte in scratch RAM) and then come back and read the second byte from each holding register to form the 16 bit accumulation in the Host system.

### 8.0 ELECTRICAL CHARACTERISTICS

### TABLE 46: ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	MIN	MAX	UNITS	COMMENTS
$V_{DD}$	Supply Voltage	-0.5	6.0	V	Note 1
V <sub>IN</sub>	Input Voltage at any Pin	-0.5	5.5	V	Note 1
I <sub>IN</sub>	Input current at any pin		100	mA	Note 1
S <sub>TEMP</sub>	Storage Temperature	-65	150	0C	Note 1
A <sub>TEMP</sub>	Ambient Operating Temperature	-40	85	0C	Industrial Temp Grade
Theta JA	Thermal Resistance: Junction-to-Ambient		7.5	<sup>0</sup> C/W	linear air flow 200ft/min (See Note 3 below)
Theta JC	Thermal Resistance: Junction-to-Case		0.5	<sup>0</sup> C/W	All conditions
M <sub>LEVL</sub>	Exposure to Moisture	5		level	EIA/JEDEC JESD22-A112-A
ESD	ESD Rating	2000		V	Note 2

#### Notes:

- 1. Exposure to or operating near the Min or Max values for extended period may cause permanent failure and impair reliability of the device.
- 2. ESD testing method is per MIL-STD-883D,M-3015.7
- 3. Linear Air flow of 200 ft/min recommended for Industrial Applications. Theta JA = 9.4℃/W with 0 Lft/min, Theta JA = 7.1 ℃/W with 400Lft/min.

#### TABLE 47: DC ELECTRICAL CHARACTERISTICS:

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNITS
$DV_DD$	Digital Supply Voltage	3.135	3.3	3.465	V
AV <sub>DD</sub>	Analog Supply Voltage	3.135	3.3	3.465	V
I <sub>CC_DS3</sub>	DS3 current consumption using PRBS 2 <sup>23</sup> -1 pattern		1016	1117	mA
I <sub>CC_E3</sub>	E3 current consumption using PRBS 2 <sup>23</sup> -1 pattern		1040	1140	mA
I <sub>CC_STS1</sub>	STS1 current consumption using PRBS 2 <sup>23</sup> -1 pattern		1100	1210	mA
P <sub>CC_DS3</sub>	DS3 Power Consumption <sup>3</sup>		3.35	3.87	W
P <sub>CC_E3</sub>	E3 Power Consumption <sup>3</sup>		3.43	3.95	W
P <sub>CC_STS1</sub>	STS1 Power Consumption <sup>3</sup>		3.63	4.19	W
V <sub>IL</sub>	Input Low Voltage <sup>2</sup>			0.8	V
V <sub>IH</sub>	Input High Voltage <sup>2</sup>	2.0		5.5	V
V <sub>OL</sub>	Output Low Voltage, I <sub>OUT</sub> = - 4mA			0.4	V
V <sub>OH</sub>	Output High Voltage, I <sub>OUT</sub> = 4 mA	2.4			V
Ι <sub>L</sub>	Input Leakage Current <sup>1</sup>			±10	μΑ
C <sub>I</sub>	Input Capacitance			10	pF
C <sub>L</sub>	Load Capacitance			10	pF

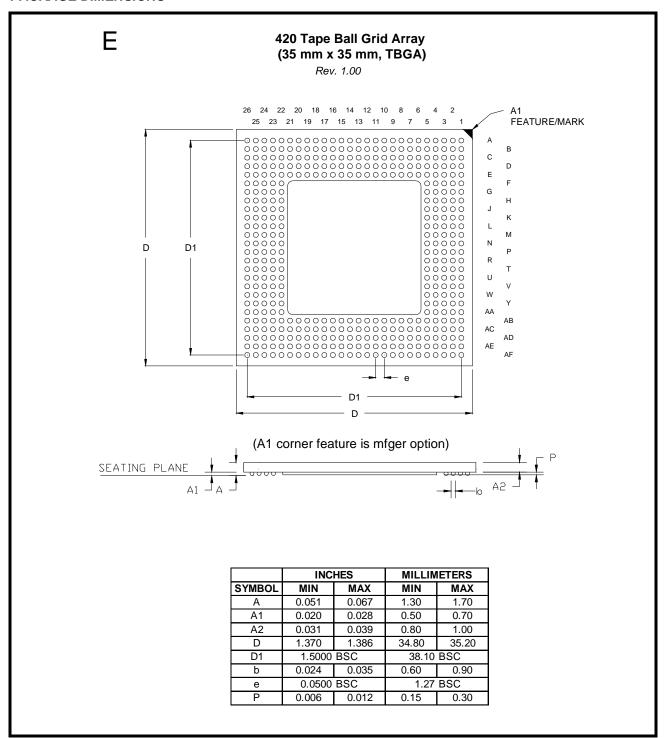
#### Notes:

- 1. Not applicable for pins with pull-up or pull-down resistors.
- 2. The Digital inputs are TTL 5V compliant.
- 3. These values are **not** a measure of Power Dissipation. These values represent the Total Power Consumption. i.e.  $P_{CC\ Consumption} = P_{DD\ Dissipation} + P_{LD\ Delivered\ to\ Load}$

### ORDERING INFORMATION

PART NUMBER	PACKAGE	OPERATING TEMPERATURE RANGE
XRT73R12IB	420 TBGA	-40°C to +85°C

#### PACKAGE DIMENSIONS -



# REVISION HISTORY

REVISION	DATE	COMMENTS
1.0.0	April 2006	Final Release Version of XRT73R12 datasheet.
1.0.1	12/07/06	Corrrected package thermal resistance specification.
1.0.2		1. Corrected global register 0x08 and added global registers 0x80 & 0x88.  2. Added (N = [0:11] & M = 0-5 & 8-D) to channelized register titles.
1.0.3	10/26/07	Theta-jC thermal value added.

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